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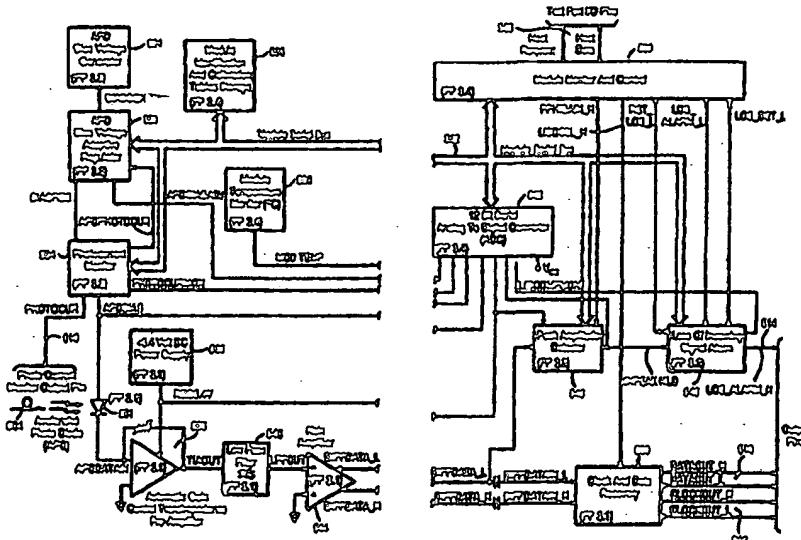
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(S4) Title: INTELLIGENT FIBEROPTIC RECEIVERS AND METHODS OF OPERATING AND MANUFACTURING THE SAME



(S7) Abstract

An intelligent fiberoptic receiver (300) and methods of manufacturing and operating the same. During calibration procedures for the receiver, the optical-to-electrical conversion device (avalanche photodiode (301) or PIN photodiode) and its supporting control and monitoring circuits in the receiver module are characterized over a defined operating temperature range. Characteristic data and/or curves defining these operational control and monitoring functions over the range of operating conditions (temperature, power supply) are stored in non-volatile memory (326) such as EEPROM. During operation, an embedded microcontroller (320) together with analog to digital converters (332), digital to analog converters and other associated circuitry, dynamically control the operational parameters of the module based on the current operating conditions (temperature, power supply).

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INTELLIGENT FIBEROPTIC RECEIVERS AND METHODS OF OPERATING AND MANUFACTURING THE SAME

BACKGROUND OF THE INVENTION

The present invention relates generally to fiberoptic receivers, and more particularly to intelligent fiberoptic receivers and methods of operating and manufacturing the same.

5 Fiberoptic data transmission systems, such as for voice and data communications, typically employ receivers having some type of optical-to-electrical converter to receive optical pulses from the fiberoptic. An example of such an optical-to-electrical converter is an avalanche photodiode or APD. Typical receivers employing such a
10 photodiode often have a bias control circuit for the photodiode that includes one or more potentiometers in order for the APD bias voltage to be set at a suitable level. As explained more fully herein, APDs typically have gain and noise characteristics that vary depending upon the particular photodiode and the particular bias voltage applied to the APD.
15 Moreover, the characteristics of the APD tend to vary as a function of temperature and with the age of the APD. Still another problem relates to APD and overall receiver performance as a function of power supply variations.

20 Designers have attempted to address such problems with various bias control and other circuits, typically employing potentiometers or other manual adjustment techniques. The manufacturing and calibration of such receivers, however, tends to be laborious, time consuming and error prone. Additionally, many such receivers tend to operate reliably only in limited temperature ranges, with the result being that undesirable
25 temperature conditions may lead to undesirable error levels or the necessity for expensive temperature control measures or periodic maintenance.

30 In general, conventional fiberoptic receivers have tended to operate reliably over limited temperature and voltage ranges, while providing limited manual adjustments such as by way of potentiometers and the like. Additionally, such conventional receivers tend to have limited overcurrent protection, and in general do not provide user programmability, except by tedious adjustment of potentiometers and the like.

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SUMMARY OF THE INVENTION

The present invention provides intelligent, adaptable, programmable receiver modules and methods of manufacturing and operating

the same, having advantages, benefits and features not found in conventional receiver modules. A receiver according to one aspect of the present invention dynamically monitors and controls parameters of the optical-to-electrical conversion device and other components of the receiver module. This is preferably done using an embedded microcontroller. During calibration procedures for an optical receiver in accordance with an aspect of the present invention, the optical-to-electrical conversion device (such as an APD or PIN photodiode) and its supporting control and monitoring circuits in the receiver module are characterized over a defined operating temperature range and voltage supply range. Characteristic data and/or curves defining these operational control and monitoring functions over the range of operating conditions (e.g., temperature, power supply voltage levels, etc.) are stored in non-volatile memory such as EEPROM. During operation, the embedded microcontroller together with analog-to-digital converters (ADCs), digital-to-analog converters (DACs) and other associated circuitry, dynamically control the operational parameters of the module based on the current operating conditions. Current operating conditions of the receiver module such as temperature and power supply levels are used in preferred embodiments as an indices into the non-volatile memory, which contains operational data tables. The table information is used to adjust the various control parameters.

With fiberoptic receivers in accordance with an aspect of the present invention, parameters that can be controlled include photodiode bias voltage, main amplifier gain, photocurrent offset, peak amplitude monitor gain and offset, loss of incoming signal (LIS) alarm trigger and hysteresis levels. Multi-level, multi-loop, mixed signal (analog and digital) automatic gain control functions operate together in preferred embodiments to extend the input power range of the receiver module as well as to provide over-current protection for the photodiode.

The microcontroller also gathers statistical information such as (a) hours of operation, (b) most extreme operating conditions, (c) conditions at time of alarm event, and (d) number of alarm events that have occurred. Such information may be stored in non-volatile memory, and certain information may be provided by way of digital or analog outputs from the receiver module. Using the hours of operation data, for example, the microcontroller also can perform aging factor compensation on necessary control parameters over the life of the module.

In specific embodiments, a serial interface to the microcontroller provides a powerful programming and monitoring channel for fully automated pre-installation calibration and in-the-field monitoring and provide users with the flexibility to monitor and/or change various parameters. The serial interface used in preferred embodiments of the present invention provides a communication channel to program the device during calibration, verification and testing. Such communication channel also provides the flexibility (if the application requires) to monitor and

change operational parameters without taking the receiver module off-line. If desired, the control information can be dynamically changed without taking the receiver module off-line.

Accordingly, the present invention provides a receiver module that is suitable for various data and voice communication applications, including what are known as Sonet/SDH transmission systems. The receiver module is adaptable to operate reliably and with acceptable error rates over a wide operating temperature range, such as, for example, -40°C to + 85°C, and also over a range of power supply voltages, such as +/- 5% of the nominal power supply voltage level. Further, the receiver module consumes a moderate or low amount of power, thereby having applicability in systems in which power consumption is a concern.

The receiver module is capable of recording data such as the highest and lowest operational temperatures sensed by the receiver module, highest bias current sensed by the receiver module, and the number of hours of operation for the receiver module, which may be used for MTBF data and APD life data collection.

Aspects of the invention provide an intelligent receiver module utilizing a "potless" design (i.e., no potentiometers), and simplified computer-controlled calibration, verification and testing methods used in the manufacture of such receiver modules, and also methods of operating such receiver modules.

The present invention further provides a receiver module that may have high sensitivity (which may be greater than -33dBm or more), and extended optical input range (dynamic range) over a range of operating conditions. Preferred embodiments of the present invention also provide a temperature and power supply compensated LIS alarm, an internally generated and auto-regulated APD bias voltage, an APD bias voltage adjusted for maximum sensitivity over a range of operating conditions, an auto-regulating APD bias voltage generator and APD over-current protection circuits, a multi-level, multi-loop, automatic gain control, a temperature and power supply compensated input power peak amplitude detector, temperature and power supply compensating LIS alarm, hardware and software LIS hysteresis, and microcontroller controlled and accessed indexing compensation tables using current temperature and power supply levels.

A further understanding of the nature and advantages of the present invention may be realized by reference to the remaining portions of the specification and the drawings.

BRIEF DESCRIPTION OF THE DRAWINGS

FIG. 1 is an overview diagram illustrating a fiberoptic receiver module in accordance with the present invention;

FIG. 2 is a circuit diagram illustrating a preferred embodiment of a fiberoptic receiver module in accordance with the present invention;

FIG. 3 is a circuit diagram illustrating the RF clock path and clock recovery circuits of a preferred embodiment of the present invention;

5 FIG. 4 is a circuit diagram illustrating the avalanche photodiode (APD) bias generator and photocurrent monitor circuits of a preferred embodiment of the present invention;

10 FIG. 5 is a circuit diagram of peak amplitude detector and loss of incoming signal (LIS) alarm circuits of a preferred embodiment of the present invention;

15 FIG. 6 is a block diagram illustrating module monitor and control portions of a preferred embodiment of the present invention;

20 FIG. 7 is a block diagram illustrating a calibration, verification and test arrangement in accordance with the present invention;

25 FIG. 8 is a graph illustrating operation of various gain control elements in various regions of operation of preferred embodiments of the present invention;

30 FIG. 9 is a graph illustrating various control voltages and associated responses in various regions of operation of preferred embodiments of the present invention;

35 FIG. 10 is a flow chart illustrating a calibration sequence for preferred embodiments of the present invention;

40 FIG. 11 is a flow chart illustrating a sequence for determining values for the calibration database in accordance with embodiments of the present invention;

45 FIG. 12 is a flow chart illustrating a sequence for determining a Best Bias Voltage (namely an APD bias having a best signal-to-noise gain) in accordance with embodiments of the present invention;

50 FIG. 13 is a flow chart illustrating a sequence for determining an LIS trigger level in accordance with embodiments of the present invention;

55 FIG. 14 is a flow chart illustrating a sequence of operation of receiver modules in accordance with preferred embodiments of the present invention;

60 FIG. 15 is a flow chart illustrating a sequence for performing module control in accordance with embodiments of the present invention;

65 FIGS. 16A and 16B are flow charts illustrating a "slow process control loop" in accordance with embodiments of the present invention; and

70 FIG. 17 is a flow chart illustrating a sequence for processing host command characters in accordance with embodiments of the present invention.

DESCRIPTION OF SPECIFIC EMBODIMENTS

Overview

Various preferred embodiments of the present invention will now be described with reference to the drawings. It should be noted that in the following discussion various elements are given names for purposes of describing the preferred embodiments of the present invention. It should be understood, however that such descriptive names should not limit the scope of the descriptions only to elements having such names.

FIG. 1 is an overview diagram illustrating a fiberoptic receiver module 500 in accordance with the present invention. A fiberoptic connector 502 serves to connect a fiberoptic 504 (which may be a single or multi-mode fiber) to a fiberoptic communication network. Fiberoptic 504 delivers optical pulses into receiver module 500. Receiver module 500 includes as inputs power supply/reference voltages 506, and includes as outputs a monitor photocurrent signal 516, a loss of signal alarm 514, clock out signals 512, and data out signals 510, the latter two of which in the preferred embodiment are differential ECL signals. Fiberoptic receiver modules in accordance with the present invention also include a serial communications port 508 for communication with receiver module 500, as more fully described below.

Fiberoptic 504 inputs a stream of optical pulses to receiver module 500 that carries encoded serial digital information received from a transmitter 503 over a fiberoptic communication channel, such as a telecommunications network. Transmitter 503 and receiver module 500 each operate in such a telecommunications or other communications network and serve to transmit voice or data communications between points in the network. Such serial digital information is supplied to transmitter 503 such as over a port 505, which also may include control channels for operation and control of transmitter 503. In certain preferred embodiments, transmitter 503 is of a type described in U.S. Application No. 08/674,059, filed on July 1, 1996, and entitled "INTELLIGENT FIBEROPTIC TRANSMITTERS AND METHODS OF OPERATING AND MANUFACTURING THE SAME," which is hereby incorporated by reference. In such preferred embodiments, such transmitters and receivers in accordance with the present invention (as more fully described below) may be synchronously controlled, operated, and maintained.

The serial digital information received by receiver module 500 is a sequence data bits having a value of either "1" or "0." Typically, a data bit with a value of "1" is represented by a light pulse, and a data bit with a value of "0" is represented as an absence of a light pulse. The bit time of the serial data is the length of time in which one bit of information is transmitted or the length of time that a single optical pulse is either on or off. The bit rate or clock rate for the serial data is the reciprocal of the bit time. The serial data transmitted by the optical pulses over fiberoptic 504 is encoded in a format that allows the serial clock signal to be recovered from the serial data stream. The

5 serial data in a preferred embodiment of the present invention is transmitted in a Pulse Coded Modulation (PCM) format that has been modified by a Pseudo Random Bit Sequence (PRBS) scrambler. The PRBS-scrambled data has the characteristic of having approximately a 50 percent duty cycle, and it minimizes the number of consecutive "0" or "1" pulses that can occur together.

10 The overall purpose of module 500 is to convert optical pulses coming into module 500 through fiberoptic 504 into electrical pulses and an associated bit rate clock signal that are output from module 500 (i.e., data output(s) 510 and clock output(s) 512). Module 500 also outputs error or loss of signal alarm 514 in the preferred embodiment when the received input power drops below a specified level. Module 500 also outputs an analog voltage corresponding to the photocurrent generated by the optical-to-electrical converter, represented by monitor photocurrent 15 516 output from module 500. In the preferred embodiment, a photodiode 501 (see, e.g., FIG. 2) is used to convert the optical energy into electrical current. The performance of receiver module 500 is measured by several key parameters, including sensitivity, optical overload, and dynamic range. The sensitivity of module 500, as used herein, is defined as the 20 minimum power level that can be received before a specified error rate occurs. The optical overload point of module 500 is the maximum power level that can be received by module 500 before a specified error rate occurs. As an example, for Sonet and STM applications, the applicable error level is 1×10^{-10} errors. The dynamic range of receiver module 500 25 is defined as the difference between the optical overload power level and the sensitivity power level.

Without being bound by theory, we will discuss various principles regarding optical-to-electrical conversion devices. There are two primary types of photodiodes used for optical-to-electrical conversion 30 in embodiments of the present invention; a P-Intrinsic-N (PIN) photodiode, and an avalanche photodiode, or APD, which is used in preferred embodiments of the present invention. Both types of devices convert optical energy into electrical current, but the APD provides an optical gain or multiplication factor in the optical to electrical conversion 35 process. This gain is referred to as the multiplication factor for the optical input at a particular APD bias voltage. An APD also generates noise that varies with the APD bias voltage and the corresponding gain as well as its temperature.

The gain or multiplication factor of the APD is a function of 40 both its bias voltage and temperature. The multiplication factor increases as the bias voltage increases, and it decreases as the temperature increases. For a specific APD bias voltage, the multiplication factor decreases as the APD temperature increases. Accordingly, to maintain the same multiplication factor as the temperature 45 increases, the APD bias voltage must be increased.

The noise generated in the APD also is a function of its bias voltage, temperature and multiplication factor. The noise from the APD's dark current (i.e., current not caused by optical input) increases as the bias voltage increases as well when the APD's temperature increases. The 5 dark current in a PIN photodiode increases only with temperature because a PIN photodiode does not have optical gain. When the multiplication factor of an APD increases, so does the noise from the APD; in other words, the "excess noise factor" of the APD increases as the multiplication factor of the APD increases.

10 As the bias voltage for an APD is increased the noise from dark current and the excess noise factor also increase. The signal to-noise-ratio combined with the receiver gain will be referred to as the receiver's "signal-to-noise gain." Therefore, there is an optimal bias voltage, referred to as the Best Bias Voltage, for an APD, which is the 15 bias voltage that provides the best signal-to-noise gain. Above this Best Bias Voltage, as the bias voltage increases the sensitivity is reduced because the noise level increases faster than the signal level. The Best Bias Voltage varies with temperature because the multiplication factor, dark current and excess noise factor of the APD all vary differently with 20 temperature.

If the bias voltage is increased above the Best Bias Voltage, a voltage will be reached where a very small increase in the bias voltage 25 will result in an exponential increase in the output current even when no optical input is present. This bias voltage is referred to as the APD's Breakdown Voltage, and in preferred embodiments of the present invention is used as a reference point in the calibration procedures, as more fully discussed below.

Thus, as provided by embodiments of the present invention, to 30 achieve the maximum sensitivity at a given temperature, the APD bias voltage is set at a level that provides an optimum signal-to-noise gain, which attempts to optimize signal gain while minimizing the amount of noise generated. As more fully described elsewhere herein, the APD bias voltage to achieve this best signal-to-noise gain is determined by a 35 calibration process where the APD is calibrated over its operating range.

While APDs are used in preferred embodiments of the present invention, PIN photodiodes are used in alternative embodiments of the present invention. As will be appreciated by those of skill in the art, 40 embodiments described herein may be modified to incorporate such PIN photodiodes, such as by providing lower voltages for biasing such PIN photodiodes, and accounting in the amplification stages for the lack of gain with PIN photodiodes as compared with APDs.

FIG. 2 illustrates in greater detail a preferred embodiment of fiberoptic receiver module 500. Receiver module 500 generally operates under control of a microcontroller 520, as more fully described herein. Microcontroller 520, along with analog-to-digital converters (ADCs), 45 digital-to-analog converters (DACs), and other associated circuitry,

dynamically controls the operational parameters of receiver module 500 based on current operating conditions, such as temperature and power supply voltage. Microcontroller 520 communicates with a set of calibration tables stored in a non-volatile memory 526 (which may be an EEPROM).

Light from fiberoptic 504 is coupled to avalanche photodiode (APD) 501, which is biased by an APD bias voltage regulator 528. APD bias voltage regulator 528 receives bias voltage from a voltage generator 524. APD bias voltage regulator 528 and a photocurrent monitor 534, which produces photocurrent monitor output 516, communicate with microcontroller 520 over a module serial bus 522. The photocurrent through APD 501 is measured by an AGC transimpedance pre-amplifier 538, which receives a supply voltage from a power supply 536. The output of pre-amplifier 538 is input to a low pass filter 540, the output of which is input to a main amplifier 544. In alternative embodiments, main amplifier 544 includes a gain adjust block including a gain adjust DAC or other element that communicates with microcontroller 520 over module serial bus 522 in order to provide adjustable gain for main amplifier 544. In certain preferred embodiments, main amplifier 544 operates at its maximum gain.

In the preferred embodiment, main amplifier 544 outputs a differential data signal to a clock and data recovery circuit 550, which produces ECL differential data outputs 510 and ECL differential clock outputs 512. Additionally, one side of the differential output of main amplifier 544 is coupled to a peak amplitude detector 546, which presents an output to a loss of incoming signal (LIS) alarm circuit 548. LIS alarm circuit 548 generates loss of signal alarm 514. Both peak amplitude detector 546 and LIS alarm circuit 548 communicate with microcontroller 520 over module serial bus 522. It should further be noted that a multi-channel ADC 532 receives analog information from a variety of the components of module 500 as illustrated and communicates with microcontroller 520 over module serial bus 522. For example, a temperature sensor 530 has an output connected to ADC 532, by which microcontroller 520 may monitor the temperature condition of module 500.

Data Path and Clock Recovery Circuits

FIG. 3 shows the data path and clock recovery circuits of the preferred embodiment of the present invention in greater detail. The current of APD 501 is coupled to AGC transimpedance pre-amplifier 538, which consists primarily of an AGC block 570 in the feedback path of an amplifier 572, with an AGC time constant generally determined by an external capacitor as illustrated. The output of amplifier 572 is coupled to a buffer amplifier 574, the output of which is coupled to main amplifier 544. Power is supplied to AGC transimpedance pre-amplifier 538 by way of power supply 536, which in the preferred embodiment constitutes a dc-to-dc converter, with appropriate feedback control and filtering as illustrated.

In the preferred embodiment, differential data outputs from main amplifier 544 are input to an input amplifier 552 of clock and data recovery circuit 550. As previously described, one of the data outputs of main amplifier 544 is coupled to peak amplitude detector 546. One output from input amplifier 552 is input to a delay 558, and another output from input amplifier 552 is input to a frequency doubler 554. The output of delay 558 is input to a flip-flop 564, an output of which is input to an ECL data buffer 568. In the preferred embodiment, ECL data buffer 568 is provided in order to provide differential ECL data outputs from module 500. The output of frequency doubler 554 is input to a surface acoustic wave (SAW) filter 556, from which the clock signal is recovered. The output of SAW filter 556 is input to an ECL clock buffer 566, which in the preferred embodiment is provided to ECL recovered clock outputs from module 500. As illustrated, termination and edge shaper circuits may be provided on clock outputs 512 and data outputs 510.

Multiplexers 560 and 562 are interposed in the recovered clock and data paths, respectively, of clock and data recovery circuit 550 as illustrated. Multiplexers 560 and 562, under control of microcontroller 520, permit an external clock and test data to be applied to clock and data recovery circuit 550.

To achieve high sensitivity with low input power, the present invention provides a receiver module that has high gain and at the same time a low base noise level, with minimal noise generated in the signal recovery and amplification process. There are several characteristics of optical to electrical conversion and input signal amplifiers used in preferred embodiments that greatly affect the signal-to-noise gain as the temperature and power supply conditions of the receiver module vary.

To provide a large dynamic range as in the present invention provides gain characteristics so that the receiver is capable accepting power levels ranging from hundreds of microwatts (1 microwatt is 10^{-6} watts) to hundreds of nanowatts (1 nanowatt is 10^{-9} watts). In order to be able to respond to such a wide range in power, embodiments of the present invent provide that the receiver is able to dynamically adjust its gain to the different input power levels.

Embodiments of the present invention extend the dynamic range of the receiver by providing automatic gain control (AGC) transimpedance pre-amplifier 538, which serves as a pre-amplifier for the receiver. AGC transimpedance pre-amplifier 538 converts the APD photocurrent drawn from its input into a corresponding voltage at its output. The automatic gain control of AGC transimpedance pre-amplifier 538 of the preferred embodiment has two regions. The first region provides a linear automatic gain control for low levels of current, which in certain embodiments is less than about 100-200 microamps. As the current increases above this level, AGC transimpedance pre-amplifier 538 goes into a "heavy AGC" mode, where the voltage output level remains constant for large increases in current. In effect, AGC transimpedance pre-amplifier 538 operates in its

linear region for low levels of optical input when the APD bias is at its maximum; as the APD bias control goes into its third region (as more fully described below) where the photocurrent begins to increase, AGC transimpedance pre-amplifier 538 then enters the heavy AGC mode and its voltage output will remain at its maximum level.

In the preferred embodiment, main amplifier 544 serves to provide gain for extremely small optical input power levels at the sensitivity level of the receiver. At such small levels, the gains of APD 501, AGC transimpedance pre-amplifier 538 and main amplifier 544 are at their maximum level and the output of main amplifier 544 is at the minimum level at which the data and clock can be successfully recovered. In certain embodiments, main amplifier 544 has an adjustable gain, when the gain of APD 501 and AGC transimpedance pre-amplifier 538 increase to the point that the output of main amplifier 544 begins to approach the maximum level for clock and data recovery circuit 550, the gain of main amplifier 544 may accordingly be reduced to maintain this level.

Clock and data recovery circuit 550 in preferred embodiments of the present invention implement a coherent detection device that uses a SAW filter that is tuned to a base incoming frequency of, for this particular example, 622.08 MHz. Such a coherent detection device can recover data and clock from input data in which the signal-to-noise ratio is much less than one. Under such circumstances, generating a suitable LIS alarm for optimum performance of the receiver module presents considerable difficulties; embodiments of the present invention provide techniques (as more fully described elsewhere herein) that substantially overcome such difficulties.

In the preferred embodiment, clock and data recovery circuit 550 is a unit provided by AT&T Microelectronics, part number TRU600A-622.08 MHZ, the users manual and/or product literature of which is incorporated herein by reference.

APD Bias Generator and Photocurrent Monitor Circuits

FIG. 4 illustrates in greater detail APD bias generator and photocurrent monitor circuits of the preferred embodiment of the present invention. A power supply 580 in the preferred embodiment provides a switched supply of -37 volts to an APD bias series voltage regulator 588 and an APD bias voltage control amplifier 586, and is implemented with a +5 to -37 volt dc-to-dc converter. One input of APD bias voltage control amplifier 586 receives a reference voltage output from an APD bias control voltage reference 582. The second input of APD bias voltage control amplifier 586 receives a variable bias adjust voltage from an APD bias voltage adjust DAC 584, which communicates with microcontroller 520 over module serial bus 522. As more fully described herein, microcontroller 520 may, depending upon the operating conditions of module 500, such as temperature and power supply voltage, adjust the bias voltage applied to APD 501.

The output of APD bias voltage control amplifier 586 is coupled to an RC time constant network 590, which serves to set the time constant of the APD bias voltage control loop. The upper node of RC time constant network 590 is coupled to the base of APD bias voltage regulator 588 and also to the collector of a current limiter transistor 608. As described more fully herein, current limiter transistor 608 serves to limit the current through APD 501 in a prompt manner so as to avoid damage to APD 501 due to an overcurrent condition.

The amount of APD photocurrent is monitored by an APD photocurrent monitoring resistor 598. The voltage drop across monitoring resistor 598 is provided to a photocurrent monitoring instrumentation amplifier 600 via resistive divider network 605. Offset adjustment to photocurrent monitoring instrumentation amplifier 600 by way of a photocurrent monitor offset adjust DAC 606, which communicates with microcontroller 520 over module serial bus 522. The output of photocurrent monitor offset adjust DAC 606 is applied to a photocurrent monitor offset adjust inverting amplifier 604, which applies an offset adjust voltage to photocurrent monitoring instrumentation amplifier 600 via a resistive divider network 605 as illustrated.

The output of photocurrent monitoring instrumentation amplifier 600 is coupled to the input of a photocurrent monitor integrator/filter 602, the output of which (which may be after low pass filtering as illustrated) is coupled to photocurrent monitor output pin 516 of module 500, and also which may be coupled to microcontroller 520 through multi-channel ADC 532 as described in more detail elsewhere herein. The output of photocurrent monitoring instrumentation amplifier 600 also is applied to a first (inverting) input of a current limit control amplifier 594, the non-inverting input of which receives a reference voltage from a current limit reference voltage source 596. The output of current limit control amplifier 594 is coupled to the control input of a voltage variable resistor 592, which is positioned in the loop between the APD bias node and the inverting input of APD bias voltage control amplifier 586.

APD Bias Control Operation

Embodiments of the present invention provide an APD bias voltage that is very stable and has low AC noise and ripple. Additionally, such embodiments also provide an APD bias voltage that is variable so the gain or multiplication factor of APD 501 may be varied according to the power of the incoming optical signal. The present invention provides such capability, while also limiting the maximum current that APD 501 can draw from the APD bias supply so as to remain below the maximum-allowed APD current level.

In preferred embodiments, the bias voltage for APD 501 is generated with a switching power supply that generates a negative supply voltage (it has been determined that a voltage of about -37 volts provides

desirable results for germanium APDs as used in accordance with preferred embodiments of the present invention). The output of APD bias power supply 580 is filtered to remove the ripple associated with the switching power supply. The output of the power supply filter goes to the auto-compensating, digitally controllable voltage regulator.

Such an auto-compensating, digitally controllable APD bias voltage regulator as provided in preferred embodiments of the present invention has been determined to provide several important functions for controlling the APD's performance. First, such controllable regulation provides the standard voltage regulation function to provide a stable bias voltage for APD 501. Second, it performs an automatic gain control function for APD 501 by controlling the APD bias voltage as a function of the photocurrent through APD 501 by using a voltage variable resistor. Third, it monitors the photocurrent flowing through APD 501. Fourth, it provides a high speed over-current protection for APD 501 by automatically "folding back" (or smoothly reducing the regulator's output current) as the APD photocurrent approaches the maximum current rating for the APD. Fifth, the regulator voltage output may be digitally controllable such as through a DAC that is loaded from microcontroller 520.

When receiver module 500 is operating, microcontroller 520 periodically measures the temperature and calculates the corresponding temperature index. Microcontroller 520 accesses a Best Bias Table in the memory using the temperature index. The Best Bias Value read from the table is loaded into APD bias voltage adjust DAC 584, which controls the APD bias voltage. This Best Bias Value becomes the maximum APD bias voltage for that temperature. The automatic gain control circuits may reduce this bias voltage for high levels of input power, but in the preferred embodiments the voltage will not go higher than this value.

The optical power levels that the receiver must respond to requires that the gain of the receiver vary by a large amount, typically at least 30 dB. To achieve the best overall gain and signal-to-noise ratio in the receiver, the gain stages in the present invention provide that the largest amount of gain was placed as close as possible to the input to the receiver, which is believed to provide advantages over other techniques.

In the receiver there are three gain stages and one gain limiting/APD current limiting stage. The gain stages are APD 501, transimpedance pre-amplifier 538, and main amplifier 544 (which in alternative embodiments may be variable). There also is an APD bias current limiting/APD gain limiting circuit to protect APD 501 from being damaged by high input power. In the preferred embodiments, each of the gain or limiting stages perform different types of AGC and each has a different time constant in responding to a change in input power.

APD bias current limiter transistor 608 and the APD bias regulator circuit (e.g., the loop incorporating photocurrent monitor resistor 598, resistive divider network 605, photocurrent monitoring

amplifier 600, current limit control amplifier 594, voltage variable resistor 592, APD bias voltage control amplifier 586 and APD bias series voltage regulator 588, which collectively are sometimes referred to below as the second analog loop) control the gain of APD 501 as a function of APD 501 photocurrent. The transimpedance gain of transimpedance pre-amplifier 538 is a function of the photocurrent that APD 501 is drawing from its input. The gain of main amplifier 544 is controlled by the peak amplitude of its output. The control response times of the various gain control stages determine which stages have the most gain and how the gain will decrease as the input power increases. The different time constants also avoid oscillations between the control of the gain stages.

APD bias current limiter transistor 608 and the APD bias regulator circuit both control the gain of APD 501 as a function of the APD's photocurrent, but they have different activation current levels and time constants, and in effect implement a "dual analog loop" control for the APD bias. The first analog loop, utilizing current limiter transistor 608, serves as a fast current limiter to respond to sudden large changes in APD current, such as if the optical input goes suddenly from zero to a large input power (such as if an optical input connection is suddenly made with receiver module 500). The first analog loop provides a quick response current limit control loop, which serves to protect and save the APD from damage due to a large, sudden overcurrent condition. The second analog loop consisting primarily of the APD bias regulator circuit has a slower response time and provides a smoother adjustment function, and which serves primarily to maintain linear bias conditions under a wide range of APD input power conditions. With the "digital control loop" provided by microcontroller 520, preferred embodiments of the present invention provide multiple analog and digital control loops, each having different response times and conditions, and each serving different overall bias control functions.

The APD bias voltage regulator circuit provides a stable bias voltage for APD 501 and controls the level of the bias voltage. The APD bias voltage is controlled in multiple ways. Microcontroller 520 sets the APD bias voltage to the calibrated Best Bias Voltage for the current module temperature. Microcontroller 520 checks the module's temperature by way of module temperature sensor 530 and adjusts the bias voltage several times a second (this is the digital control loop discussed above). The second way that the APD bias voltage is controlled is by using the APD photocurrent that is monitored through photocurrent monitoring resistor 598 and amplifier 600, etc., to provide an automatic gain control function (this is the second analog loop discussed above).

Microcontroller 520 adjusts the APD Best Bias Voltage in small increments as the module's temperature varies slowly with time. For the discussion of the APD bias voltage regulator circuit's automatic gain control function, the Best Bias Voltage will be considered to be constant value with respect to the response time of the automatic gain control

function. The AGC response time of the APD bias voltage regulator circuit is much longer than the response time of current limiter transistor 608. Also the photocurrent level at which the APD bias voltage regulator circuit's AGC function becomes active is much lower than that of current limiter transistor 608. Therefore, for slow changes in optical power and when the photocurrent is below the activation level of current limiter transistor 608, the APD bias voltage regulator circuit controls the level of the APD bias voltage.

The APD bias voltage regulator circuit of the present invention monitors the photocurrent that is being drawn by APD 501 and uses this information to control the APD's bias voltage. The output voltage of the voltage regulator circuit is determined by the resistance in its control feedback loop. Voltage variable resistor 592 is used in this feedback loop to provide a resistance that can be controlled as a function of the monitored APD photocurrent.

The photocurrent level at which the APD bias voltage regulator circuit begins to perform its AGC function is at approximately the level at which transimpedance pre-amplifier 538 leaves its linear region of AGC control and begins heavy AGC control. At photocurrent levels lower than the voltage regulator AGC activation point, the APD gain is constant at the Best Bias Voltage level and the gain of transimpedance pre-amplifier 538 is varying.

The APD bias voltage control functions that the APD bias voltage regulator circuit performs in preferred embodiments of the present invention can be described in five different regions under varying optical input conditions.

In region 1, the photocurrent is below the APD bias voltage regulator circuit's AGC threshold. In this region, the APD bias voltage is equal to the calibrated Best Bias Voltage. This is the voltage for the current temperature that provides the "best signal-to-noise gain." This Best Bias Voltage is updated as the module temperature changes. In this region, the transimpedance gain of transimpedance pre-amplifier 538 is at its maximum. The ac output of transimpedance pre-amplifier 538 increases as the optical input power increases. The gain of the main pre-amplifier 544 is at its maximum in this region (including with embodiments having a variable gain main amplifier, etc.), with the output of main amplifier 544 increasing as the optical input power increases.

In region 2, the output of main amplifier 544 has reached its maximum value and its output goes into a voltage limit mode of operation. In this mode the output voltage of main amplifier 544 does not increase even though its input voltage increases. In this region the gain of APD 501 and transimpedance pre-amplifier 538 operate the same as in region 1.

In region 3, the photocurrent has reached the AGC threshold of the APD bias voltage regulator circuit and current through photocurrent monitor 534 is being held constant. In this region the APD bias voltage regulator circuit's AGC function reduces the APD bias voltage as the

optical power increases. This results in holding the photocurrent constant at the AGC threshold value even though the optical power is increasing. In this region the output voltage of transimpedance pre-amplifier 538 remains at a constant level because the photocurrent input to transimpedance pre-amplifier 538 is constant, even though transimpedance pre-amplifier 538 remains in the linear region. In this region, current limit control amplifier 594 changes the resistance of voltage variable resistor 592. This causes APD bias voltage control amplifier 586 to reduce the APD bias voltage from the APD Best Bias Voltage value down to the APD bias control reference voltage output from voltage reference 582. As the resistance of voltage variable resistor 592 decreases, the IFDBAK current increases, which causes the IMON current to increase even though the ILIM and the photocurrent monitoring voltage divider 605 current are decreasing as the APD bias voltage decreases.

In region 4 the APD bias voltage regulator circuit AGC reaches its maximum limit and the APD bias voltage regulator circuit reduces the APD bias voltage to the value of the reference voltage from APD bias control voltage reference 582 (-2.5 volts in the preferred embodiment). In this region the APD bias voltage remains at the reference voltage level and the gain control function is controlled by transimpedance pre-amplifier 538. In this region transimpedance pre-amplifier 538 begins its AGC mode.

In region 5, the photocurrent reaches the point where the voltage drop across the resistor in fast response current limiter 608 reduces the APD bias voltage below the reference voltage from voltage reference 582.

As will be appreciated from the description of preferred embodiment provided herein, fast response current limiter 608 provides overcurrent protection for APD 501 as well as high speed automatic bias level/AGC control by limiting the current that can flow through series voltage regulator 588 and by lowering the APD bias voltage as the current is limited. The activation point of fast response current limiter 608 is set at a higher activation level than the APD bias voltage regulator circuit and fast response current limiter 608 has a much faster response time. Fast response current limiter 608 has a response time of several microseconds such that it can quickly protect APD 501 when a large increase in optical power occurs. Fast response current limiter 608 responds at the switching speed of the amplifiers in fast response current limiter 608 and series voltage regulator 588, and in preferred embodiments no significant additional R/C time constants limit the response time of this circuit.

With no optical input power or with very low input power, the gain of APD 501 is set to its maximum value by the bias control circuits. This maximum bias voltage is the Best Bias Voltage that was determined during calibration for the module's current temperature. When the gain of APD 501 is high, a large change in optical input power will cause a very

large change in APD photocurrent. In preferred embodiments, when the APD photocurrent reaches approximately two thirds of the maximum allowable photocurrent, fast response current limiter 608 begins to shut off the current flowing through series voltage regulator 588 as will reduce the APD bias voltage. As the APD bias voltage is decreased, the gain of APD 501 also will decrease, which will cause the photocurrent to decrease. At this point, fast response current limiter 608 is in an automatic gain control mode. As the photocurrent continues to increase, fast response current limiter 608 continues to cut off the photocurrent and decreases the bias voltage thus holding the photocurrent constant. The automatic gain control function will continue to operate until the APD bias voltage and APD gain are decreased to their minimum values.

Such a multi-loop control for APD bias and current in accordance with embodiments of the present invention is submitted to provide significant advantages over conventional APD circuits.

FIG. 8 is a graph illustrating operation of various gain control elements in various regions of operation of preferred embodiments of the present invention, and FIG. 9 is a graph illustrating various control voltages and associated responses in various regions of operation of preferred embodiments of the present invention. As will appreciated from FIGS. 8 and 9, in accordance with the present invention, various gain and bias control elements and loops are provided in order to provide stable ADP bias and overall receiver module operation over a wide range of operating conditions.

25 Peak Amplitude Detector and Loss of Incoming Signal (LIS) Alarm Circuits

FIG. 5 is a circuit diagram of peak amplitude detector 546 and loss of incoming signal (LIS) alarm circuit 548 of the preferred embodiment of the present invention. The output of main amplifier 544 is input to a temperature compensated rectifier 610, the output of which is coupled to a peak amplitude amplifier 618 having a peak amplitude adjustable gain block 616, which receives a control input from microcontroller 520. Microcontroller 520 also communicates with an LIS adjust DAC 612 over module serial bus 522. Through an inverting amplifier 614, LIS DAC 612, under control of microcontroller 520, may adjust the offset presented to peak amplitude amplifier 618.

The output of peak amplitude amplifier 618 is coupled to the inverting input of a high-speed LIS comparator 624. The non-inverting input of LIS comparator 624 receives the output of an LIS compare level generator and software hysteresis DAC 620 summed with the output of a comparator hardware hysteresis block 622. The output of LIS comparator 624 (LIS detect signal) is coupled to microcontroller 520 and also to the set input of an LIS alarm latch 626, which generates a loss of signal alarm that is coupled to microcontroller 520 and to loss of signal alarm output 514 of module 500.

The efficiency of the optical-to-electrical conversion, the amount of noise generated in the conversion, and the gain of the different amplification stages all vary with temperature and power supply. Because of the filtering and phase locking techniques used in preferred 5 embodiments of the present invention, the clock and data recovery circuit 550 can recover the data and clock from a signal where the signal-to-noise ratio is much less than one. The signal amplitude and the amount of noise generated vary with both temperature and power supply, therefore, to accurately detect the loss of signal power level requires that the peak 10 amplitude detector be compensated as the temperature and power supply change.

The LIS alarm is asserted when the input power coming into the optical detector drops below a power level that is calibrated to a specified error rate. In preferred embodiments, this power level is at 15 least 1 dB below the input power level at which the 1×10^{-3} bit error rate occurs. To generate the LIS alarm, the average peak amplitude voltage (INPEAKHLD) of the data signal is compared to an LIS trigger comparison reference voltage (LISCOMP) using LIS comparator 624. The LIS trigger comparison reference voltage is generated using DAC 620, which is loaded 20 by microcontroller 520 from a set of look up tables. The values for the look up tables are determined during the calibration process and incorporate "software hysteresis" within the trigger level as more fully described elsewhere herein

The average peak amplitude of the voltage between main 25 amplifier 544 and clock and data recovery circuit 550 is used as the comparison voltage for turning on and off the LIS alarm. The voltage between main amplifier 544 and clock and data recovery circuit 550 is rectified using high speed switching diodes (temperature compensated 30 rectifier 610) and is filtered, averaged with a peak hold circuit, and amplified to generate the average peak amplitude voltage. The peak amplitude voltage goes to one input of LIS comparator 624, which is used to generate the LIS alarm detect signal. The trigger comparison voltage for the other side of the comparator is controlled by DAC 620, which is loaded by microcontroller 520. The value for the trigger comparison 35 voltages for turning on and off the alarm are determined during calibration as more fully described elsewhere herein.

The methods used for measuring the input power level are based 40 on rectifying the ac RF data signal and detecting its peak level using a peak amplitude detector circuit. In the preferred embodiment, the LIS alarm is configured so as to not assert for sequences of less than 100 consecutive identical digits (either 1's or 0's). Therefore, the peak 45 amplitude detector must hold the peak amplitude of the last "1" data bit for longer than 100 bit periods (e.g., in the preferred embodiment, about 160 nanoseconds). This requires an averaging peak amplitude detector be used for determining the power level of the input signal. The LIS alarm of the preferred embodiment also asserts in less than 25 microseconds;

therefore, the time constant for the averaging peak amplitude detector must be between the limits to meet the consecutive identical digits requirements and the alarm assertion requirements.

Another challenge to overcome in the present invention is that, in generating the LIS alarm for a particular input power level, the peak amplitude voltage coming from the peak amplitude detector varies as power supply and temperature vary. There are several components in the RF input path, and the performance of each of these varies differently with temperature and power supply changes. Because of such variations, the peak amplitude voltage is a complex function of several variables changing at different rates in several different devices. Because of these variations, the comparison level for turning on and off the LIS alarm at a specific power level is adjusted in preferred embodiments as the receiver's temperature and power supply levels change. Also, as the module's temperature changes the input power level that causes a 1×10^{-3} bit error rate also changes.

As more fully described elsewhere herein, the bit error rate tester (BERT) has a sync loss function that can be set to a 1×10^{-3} error rate. During calibration, this sync loss function of the BERT is used to determine the attenuation setting for the optical attenuator required for a bit error rate level of 1×10^{-3} . The LIS compare level generator DAC (DAC 620), which generates the LIS trigger comparison reference voltage, is set to zero and the optical attenuator is set to the power level at which the alarm is to assert (typically 1 to 2 dB below sync loss). The value in LIS compare level generator DAC 620 is increased until the output of the comparator asserts. The output of the comparator is referred to as the LIS error detect signal. The value in LIS compare level generator DAC 620 that causes the LIS error detect signal to assert is stored in memory along with its associated temperature and power supply setting. At each temperature step in the calibration process, the module is tested at the minimum and maximum power supply settings and the values are stored.

When the LIS error detect signal asserts, a small portion of its positive output is fed back to the comparator's positive input. This provides a small positive hardware hysteresis when the comparator changes state. This positive feedback reinforces the change and prevents the output of the comparator from oscillating for small variations in the input level around the turn on trigger level.

The trigger level for turning off the LIS alarm is typically one to two dB above the power level that caused the alarm to assert. The compare value in LIS compare level generator DAC 620 for turning off the alarm is determined by setting the optical attenuator to the power level at which the alarm is to turn off and then determining the DAC control value at which the alarm turns off. After the LIS alarm turns on during the calibration process, LIS compare level generator DAC 620 is set to its maximum value before the optical attenuator is changed to the off power level. After optical attenuator is set to the desired alarm turn off

value, the value in LIS compare level generator DAC 620 is then decreased until the alarm turns off. This value is stored in the calibration data as the LIS alarm software hysteresis off value.

5 The data from the module calibration is converted into tables that are indexed by temperature and power supply levels. The calibration tables are loaded into non-volatile memory in the receiver module and used by microcontroller 520 during operation of the module to adjust the value in the LIS compare level generator DAC 620 as the module's temperature and power supply change.

10 Module Monitor, Control and Table Indexing

FIG. 6 is a block diagram illustrating module monitor and control portions of the preferred embodiment of the present invention. Microcontroller 520 communicates with various components of module 500 including calibration table memory 526 by way of module serial bus 522. 15 Microcontroller 520 also receives information from various analog components of module 500 by way of multi-channel ADC 532, certain inputs of which are coupled through ADC input filters 636 and/or various dividers or other circuit blocks. For purposes of the present invention, it is important that ADC 532 receive inputs from appropriate components of 20 module 500 in a form that is suitable for accurate capture of the incoming analog information (i.e., at an appropriate portion of the ADC input signal range, etc.). In the preferred embodiments: module temperature monitor 530 is coupled to ADC input filters 636; the APD bias voltage from the output of photocurrent monitor 534 (from APD bias voltage regulator 25 528) is coupled to ADC input filters 636 through a voltage divider/input amplifier 638; the voltage from power supply 536 is coupled to ADC input filters 636 through a voltage divider 640; the voltage from the main VCC supply is coupled to ADC input filters 636 through a voltage divider 642; and inputs from APD bias generator 528, photocurrent monitor 534, peak 30 amplitude detector 546, and the noninverting input of the LIS comparator are directly connected to ADC input filters 636.

The way that microcontroller 520 references the calibration tables stored in non-volatile memory 526 using the current module temperature will now be described in more detail. The microcode executed 35 by microcontroller 520 continuously monitors the module's temperature, indexes the tables and updates several control voltages using 12-bit (in preferred embodiments) DACs. Microcontroller 520, which in one embodiment is a Motorola 68HC05, computes an index into the table as a function of temperature. To understand how such indices are computed, it is first 40 necessary to understand the operation of the internal temperature sensor and ADCs used in certain embodiments of the present invention. It is understood that such discussion is for understanding in better detail how memory indexing in certain preferred embodiments is implemented, but that such discussion is not intended to serve as a limitation on other 45 embodiments/aspects of the present invention. For example, in certain

alternative embodiments polynomial coefficients are stored and utilized in order to calculate various operational parameters, etc.

The temperature sensor (such as temperature monitor 530) outputs a voltage based on sensed temperature. In the preferred embodiment, the voltage output (V) of the sensor is equal to the temperature (T_K) in degrees Kelvin $\times 10$ millivolts. In other words, the voltage increases by 10 millivolts for every degree of temperature increase. The ADC uses a reference voltage of 4.096 volts, meaning that the full scale range of the sampled signal is from 0 volts to 4.096 volts (the ADC output coding will change by one LSB for every 1 millivolt of analog input change). This translates into a full scale temperature range from 0°K to 409.6°K. As is well known, temperature in degrees Kelvin (°K) is easily converted to degrees Celsius (°C) by the formula $^{\circ}\text{C} = ^{\circ}\text{K} - 273$. In this exemplary discussion, the full scale temperature range in degrees Celsius is then approximately -273.0°C to +136.6°C, which, of course, exceeds typical temperature ranges for receiver modules.

Preferred embodiments seek to make the computation of the table index as simple as possible, which may enable use of low-cost microcontrollers such as the 68HC05 (i.e., which does not directly support floating point calculations). Binary division and multiplication can easily be accomplished by simple shift operations. Therefore performing division by 2, 4, 8, 16 ..., etc. is easily accomplished with such a microcontroller. Due to the nature of the temperature sensor and the ADC, temperature changes of 0.1°C will be detected. If a temperature range of -55.0°C to 104.9°C (explained below) is selected as a valid range to index the table, then 1600 discrete values are possible (-55.0°C to 104.9°C in 0.1°C steps yields 1600 possible discrete values). The EEPROM/non-volatile memory used in the preferred embodiment only contains 512 bytes, and therefore 1600 12-bit values for a DAC adjust table is not an adequate solution. Rather than have the table index on 0.1°C steps, a larger step is used in preferred embodiments of the present invention. Having 50 entries in a table would require 100 of the 512 bytes, which is a more reasonable approach (each entry contains two bytes in order to obtain at least 12 bits). Dividing the temperature range into 50 entries would yield a 3.2°C step between table entries (this translates to an ADC step of 32 counts between entries). A temperature range of -55°C to 104.9°C translates to an ADC range of 2180 to 3779. In certain preferred embodiments, the 68HC05 microcontroller computes the table index for a 50-word 16-bit word table in the following manner. (1) Read the temperature via the ADC and obtain a 12-bit value N . (2) If the value N is out of range, force N to an upper or lower limit. Valid temperatures are defined from -55.0°C ($N=2180$) to 104.9°C ($N=3779$). These temperature extremes are outside the range of a -40°C to +85°C module (as in preferred embodiments of the present invention), but are used as boundaries in the table (i.e., the table has some margin which extends beyond the preferred embodiment's range boundaries). (3) De-bias the temperature by

subtracting 2180 from the value N. This essentially correlates the [0] index (0th element of the table) with -55°C. If the temperature read via the DAC is -55.0°C (N=2180), then subtracting 2180 from N will yield a result of 0. After subtracting 2180 from N, N will vary from 0 to 1599 (1600 possible discrete values of N). (4) Divide the result of the previous operation by 16. This is accomplished with 4 shift right zero instructions. This will result in a byte index between 0 and 99. (5) The least significant bit of the previous operation is then cleared. This truncates the result to an even address providing a byte index of the MSB of the table 16-bit word entry. This results in an even byte index not greater than 98. Adding this byte index to the base address of the table will point to the MSB of the 16 bit value to be read from the EEPROM, such as reading a 12-bit value to be loaded into a DAC used in the present invention.

This indexing scheme of the preferred embodiment results in 50 word entries in the table. Each entry in the table covers a 3.1°C temperature spread. There is a 3.2°C step between the base temperature associated with one table entry and its adjacent entry. Also in the preferred embodiment, the APD best bias adjust table/peak amplitude gain control table, the LIS on compare level table, and the LIS off hysteresis compare table are 50-word entry tables. In the preferred embodiment, the LIS on compare voltage adjust table is a 50 byte table and requires a different index, and the photocurrent offset zero adjust table and the peak amplitude offset adjust table contain 25 word entries. In the preferred embodiment, these two indices are derived by further dividing the byte index (50 words). The byte index for the 50-byte table is generated by doing a one logical shift zero right operation. The byte index for the 25-word tables is generated by clearing bit 0 of the byte index (50 Bytes). The 25-word tables cover a 6.2°C temperature spread.

The compare voltage for turning on and off the LIS alarm is a function of the positive power supply voltage. Microcontroller 520 in the preferred embodiment compensates for the current power supply when determining the LIS alarm trigger level. During calibration the LIS alarm on trigger level and off trigger level are determined for both minimum and maximum power supply values. The voltage between the minimum and maximum power supply is divided into 16 voltage compensation partitions. The first voltage partition of zero corresponds to the actual trigger levels determined at the minimum power supply settings. Therefore, for the first voltage compensation partition no compensation is required because the LIS and hysteresis table entries already contain the actual value for minimum power supplies. There are 15 voltage partitions between this minimum entry and the value required for the maximum power supply.

The size of the voltage compensation per partition is determined by subtracting the trigger level at maximum power supply from the trigger level at minimum power supply and then dividing this value by 15. The voltage partition compensation values for the LIS on trigger

level values are stored in the LIS on compare voltage compensation table and the voltage partition compensation values for the LIS off trigger level are stored in the LIS off compare voltage compensation table.

The microcode continuously monitors the VCC power supply plane (+5 volts) using a 12-bit ADC. A divide by 2 voltage divider is used to read the VCC voltage to keep it within the input range of the ADC. If the voltage read is outside of the allowed tolerances, the value read is limited to the upper or lower power supply tolerance value. The lower power supply tolerance divided by 2 is then subtracted from the limited value read to provide a number between 0 and 250, for 250 millivolts. This number is divided by 16 using for shifts to determine the voltage partition number of the current power supply level.

Module Calibration and Testing

FIG. 7 is a block diagram illustrating a calibration, verification and test arrangement in accordance with preferred embodiments of the present invention. Modules 500 to be calibrated, etc. are mounted on boards 676, which are inserted into slots on a test backplane 674, to which is coupled RS485 communication control unit 672. Modules 500 are calibrated in an environmental chamber 670, which in the preferred embodiments is controlled by a GPIB chamber controller 668 under control of a test/calibration computer 650. It has been determined that, with intelligent modules as provided in accordance with the present invention, a large number of such modules may be calibrated, verified and tested in an efficient manner using such a backplane approach.

Test/calibration computer 650 communicates over a bus 651 to a variety of the components utilized in calibration systems in accordance with the present invention. Test/calibration computer 650 communicates with a clock generator 652, a pattern generator 654, a reference optical transmitter 656, an optical attenuator 658, and an optical multiplexer 660 in order to provide optical pulses to the modules under test. Test/calibration computer 650 communicates with a power supply 662, which supplies power to test backplane 674, and also with RS485 interface 664, which provides serial communication capabilities to communication control unit 672. Additionally, test/calibration computer 650 communicates with a multiplexer 680 and a bit error rate tester (BERT) 682, which receive signals from modules 500 being calibrated, etc., in environmental chamber 670. In the preferred embodiments, all such components communicate over a common GPIB-type interface base, thereby enabling computer control of various test and calibration procedures in accordance with the present invention.

The Best Bias Voltage for the module is measured at multiple points over the modules' operating temperature range and the data is stored for generation of the Best Bias Calibration Curves or Tables. This Best Bias Voltage data is measured using pattern generator 654, optical attenuator 658, BERT 682, computer 650, and environmental chamber 670.

The APD Bias Voltage can be varied by a host computer using the serial test interface to the module and the corresponding error rate for that voltage can be measured by BERT and read by the host computer through the GPIB bus interface between the host and the BERT.

5 The environmental chamber is controlled by the host computer using the GPIB bus. The chamber is stabilized at one of the calibration temperatures and then the host computer varies the APD's Bias Voltage within the module. The APD bias voltage is varied using the serial interface to the module to load a DAC that controls the level of the APD bias voltage.

10 The Breakdown Voltage for the APD is used as the reference point in finding the Best Bias Voltage. The Best Bias Voltage is typically around 0.9 of the Breakdown Voltage, but it will vary with temperature. The Breakdown Voltage is found by disabling the optical input and then increasing the bias voltage until photocurrents in the range of hundreds of microamps are measured.

15 Finding the Best Bias Voltage is a two-step process, first a course bias adjust is used to find the approximate Best Bias Voltage, and then a finer resolution is used to determine the Best Bias Voltage with more accuracy. During the first phase, the APD Bias Voltage is varied by the host computer from 0.7 of the Breakdown Voltage up to the Breakdown Voltage and error rate is then measured for each voltage. The APD bias voltage with the lowest error rate is used as the center of the sweep for the finer resolution bias voltage sweep. The lowest error rate at the finer resolution becomes the Best Bias Voltage for that temperature. The modules temperature is measured through the serial interface to the microcontroller and is stored along with the best bias data.

20 The Best Bias Calibration data is converted into a temperature indexed table. To generate the temperature index, the operating temperature range for the table is divided into "n" partitions. "N" is determined by dividing the temperature range by the temperature resolution (degrees C per partition). The number of partitions needed is determined by the linearity of the data to be stored in the table and by the slope of the calibration data to temperature curve. The data points taken during calibration are loaded into the table at temperature index locations corresponding to the measured module temperatures for that data. After the calibration data has been loaded, the empty points in the table are filled in by interpolating between the calibration points.

25 To more fully understand preferred embodiments of the present invention, which include methods of manufacturing (calibrating, verifying, testing, etc.) and operating receiver modules, FIGS. 10-18 will now be described. In discussing FIGS. 10-18, references may be made to elements included in other of the figures, for example, FIG. 7.

30 FIG. 10 is a flow chart illustrating a sequence used in the manufacturing, calibration, testing, verification, etc., of receiver modules in accordance with preferred embodiments of the present invention.

At a step 699, the start-up (or power-up, etc.) sequence is initiated, and a receiver module calibration process begins. At a step 700, test/calibration computer 650 performs a roll call with receiver modules 500, which may be in environmental chamber 670, over bus 651 and serial communications port 508. As a result of this process, computer 650 determines the number, type and identification, etc., of the receiver modules to be calibrated. In preferred embodiments, each of receiver modules 500 has a unique identifying serial number.

At a step 702, environmental test chamber 670 is controlled by computer 650 to be set at the upper operating extreme, for example 85 degrees C. Step 702 is maintained for a time sufficient for receiver modules 500 to reach equilibrium at the upper operating temperature. At a step 704, in the preferred embodiment, a particular receiver module 500 is selected for calibration. In other embodiments, components shown in FIG. 7 may be duplicated so that multiple of receiver modules 500 may be calibrated in parallel.

At a step 706, under control of computer 650, parameters for the selected receiver module are determined, which in the preferred embodiment include the Best Bias Voltage, LIS trigger and hysteresis levels, photocurrent monitor zero offset adjust, peak amplitude detector gain level and peak amplitude detector zero offset adjust level, and such calibration data is logged to a calibration database 710. Step 706 will be discussed in more detail in connection with FIGS. 11-13.

At a step 708, a determination is made as to whether all of receiver modules 500 in environmental chamber 670 have been calibrated. If not, then the process returns to step 704 and another of receiver modules 500 is selected. If yes, then the process proceeds to a step 712. At a step 712, a determination is made as to whether calibration has been completed at the lowest operating temperature (i.e., have the modules been calibrated over the entire, desired temperature range). If no, then at a step 714 computer 650 adjusts (decrements, in preferred embodiments) the temperature of environmental chamber 670, and, after reaching equilibrium, the process returns to step 704 to select one of receiver modules 500 to be calibrated at the new temperature. If yes, then at a step 716 look-up tables are created that will be accessed by microcontroller 520 during operation of receiver modules 500. Such look-up table data is stored in a calibration table archive 720. At a step 718, the operation of each of receiver modules 500 may be verified over the entire desired temperature and power supply operating ranges.

FIG. 11 illustrates in greater detail step 706 of FIG. 10. At a step 722, the selected receiver module is initialized and a "clock to data alignment" is performed. Generally, at a step 722, computer 650 adjusts elements such as optical attenuator 658, initializes the particular one of receiver modules 500 that is to be calibrated, confirms the particular of receiver modules 500 to be calibrated and its temperature, using a microwave transition analyzer, for example, to

perform a clock to data alignment, and to otherwise put the calibration components and receiver module 500 in condition for further calibration steps.

At a step 724, the APD bias for best signal-to-noise gain (i.e., the Best Bias Voltage) is determined. Step 724 is discussed in greater detail in connection with FIG. 12. At a step 726, the photocurrent monitor output is adjusted for zero offset for no light input. At a step 728, the peak amplitude detector output is adjusted for zero offset for no light input. At a step 730, the attenuation level for LIS alarm to activate is determined (for example, the attenuator is adjusted so that the LIS alarm reliably asserts below a 1×10^{-3} bit error rate level in preferred embodiments). At a step 732, the LIS trigger level compare value for alarm turn-on is determined. Step 732 is discussed in greater detail in connection with FIG. 13. At a step 734, the LIS trigger level compare value for alarm turn-off is determined. As previously described, this trigger level in preferred embodiments is determined by adjusting attenuator 658 so as to be one to two dB above the power level for turn-on, which desirably adds in accordance with the present invention LIS software hysteresis. Step 734 in preferred embodiments is performed by setting LIS level control DAC 620 to its maximum setting, adjusting attenuator 658 as described above, and then decrementing DAC 620 until LIS alarm latch 626 turns off. At a step 736, the calibration data is logged to calibration database 710. At a step 738, the process returns to the sequence illustrated in FIG. 10.

FIG. 12 is a flow chart illustrating a sequence for determining an APD bias having a "best signal-to-noise gain," i.e., the Best Bias Voltage, at a step 724 in accordance with embodiments of the present invention. At a step 740, in preferred embodiments optical attenuator 658 is stepped to an attenuation value at which at least 50 to 100 errors per second are occurring. An exemplary setting is 39 dB. At a step 742, a first pass course sweep of the APD bias voltage is performed, during which the APD bias is swept from 80% of the APD Breakdown Voltage to the APD Breakdown Voltage in "n" steps (e.g., 8 steps). At each step, the number of errors (with BERT 682) occurring at a predetermined time interval at the particular APD bias setting is determined, examples being 3 to 4 seconds, or at least 2, 3, 4, or 5 seconds being determined to provide desirable results in terms of accuracy/time efficiency in accordance with the present invention.

At a step 744, the APD bias voltage at which the smallest number of errors occurred is determined, and this bias voltage level is used as a basis for a second pass fine sweep of the APD bias voltage. In preferred embodiments, the determined bias voltage level is used as a center point for the second pass fine sweep, with the range of the second pass sweep being +/- 125% of the step interval of the first sweep. The dual pass sweeping technique has been determined to provide a particularly

expedient method of determining an appropriate APD bias voltage in accordance with preferred embodiments of the present invention.

At a step 746, the second pass fine sweep of the APD bias voltage is performed in, for example, "m" steps (such as $m = 6$), and the number of errors (with bit error rate tester 682) occurring at a predetermined time interval at the particular APD bias setting is determined. The bias voltage having the fewest number of errors is the Best Bias Voltage in accordance with preferred embodiments of the present invention. In alternative embodiments, additional finer sweeps may be performed to determine an optimum APD bias level. At a step 748, the process returns to the sequence illustrated in FIG. 11.

FIG. 13 is a flow chart illustrating a sequence for determining an LIS trigger level at a step 732 in accordance with embodiments of the present invention. At a step 762, the LIS alarm on attenuation is set to the loss of sync attenuation plus a predetermined margin, which in preferred embodiments is 1.25 dB. At a step 764, a determination is made as to whether the LIS attenuation level is greater than the maximum LIS attenuation level. If yes, the LIS on attenuation level is set to be equal to the maximum LIS attenuation. If no, the process proceeds directly to step 766.

At a step 766, the LIS alarm turn-on trigger value for LIS compare DAC 620 is determined, in preferred embodiments by incrementing LIS compare DAC 620 until the LIS alarm turns on. At a step 770, it is determined whether this is the minimum power supply loop. If no, then the process returns to the sequence illustrated in FIG. 11. If yes, then at a step 772 the compare control value is compared with the high gain limit, which in preferred embodiments is 1500. If no, then the process at a step 784 returns to the sequence illustrated in FIG. 11. If yes, then at a step 774 the LIS alarm turn-off trigger value for LIS compare DAC 620 is determined, in preferred embodiments by decrementing LIS compare DAC 620 until the LIS alarm turns off.

At a step 776, the on and off compare values calibrated at the high peak amplitude gain setting are saved. Then, because LIS compare DAC 620 may reach its limit, the gain is set to low, attenuator 658 is set to the loss of sync attenuation setting and the loss of sync voltage is set for low gain. At a step 778, the LIS trigger level compare value for alarm turn-on is determined for the new low gain settings. At a step 780, the process returns to the sequence illustrated in FIG. 11.

Module Operation

Using the data stored in non-volatile memory 526, which is accessed by microcontroller 520 during operation of receiver modules in accordance with the present invention, such receiver modules adapt various parameters in order to adapt the receiver module's performance in response to changing conditions. Such operation will be described in greater detail in connection with FIGS. 14-17.

FIG. 14 is a flow chart illustrating a sequence of operation of receiver modules in accordance with preferred embodiments of the present invention. It is assumed that such receiver modules have been calibrated with a process such as described above. At a step 800, the module is powered up. At a step 802, microcontroller 520 accesses stored data 804 (such as non-volatile memory such as EEPROM) and sets register port directions and initial values, sets a loop scan counter to 0, sets DAC values and flags to initial values, resets the LIS detect signal (i.e., reset alarm latch 626). Microcontroller also gets the current module temperature and the current VCC monitor value. At a step 806 a test is performed as to whether a host service request (external controlling computer, such as test computer 650 or some other controlling computer, such as a controlling computer for the communication network in which the receiver module is operating) has been asserted (such as over serial port 508 or other control pin of microcontroller 520). Based on the test of step 806, at a step 808 a determination is made of whether a host request has been asserted. If yes, the process proceeds to a step 810 to service the host request. If no, the process proceeds to a step 818 to perform a module control sequence.

At a step 818, a module control process is performed. At a step 820, a reset time-out count is performed and the process returns to step 806. The timeout counter in microcontroller 520 is used to provide a processor reset function (or "watchdog timeout"). The timeout counter is hardware incremented and, if it overflows, causes reset of microcontroller 520. During normal operation, the timeout counter is periodically reset by software in order prevent such resetting. Step 818 will be discussed in greater detail in connection with FIGS. 15, 16A and 16B.

Processing in the event of host request assertion (yes at step 808) will now be described. At a step 810, an acknowledgment is sent to the host computer. At a step 812, a command character is retrieved from the host. At a step 814, a determination is made as to whether the host request is still asserted. If no, the process returns to a step 806. If yes, the process proceeds to step 816, during which the host command character is processed. Step 816 is described in greater detail in connection with FIG. 17.

FIG. 15 illustrates in greater detail step 818 of FIG. 14. At a step 824, a check is made of the LIS alarm and the LIS trigger comparison hysteresis. At a step 824, it is determined whether the LIS alarm is set, and, as appropriate, outputs of clock recovery and data circuit 550 are enabled or disabled, LIS flag is set or reset, and any software hysteresis processing is carried. For example, in preferred embodiments the software hysteresis is used to set a higher value to LIS compare level DAC 620 after LIS has been detected, and at a step 824 such setting to a higher value (or resetting if the LIS is no longer detected, etc.) is performed. The functions of step 824 are repeated periodically throughout software execution in order to meet a predetermined time

having a high degree of adaptability and programmability are provided, as well as novel methods of manufacturing and operating such receiver modules.

Although various preferred embodiments of the present invention have been disclosed for illustrative purposes, those skilled in the art will appreciate that various modifications, additions and/or substitutions are possible without departing from the scope and spirit of the present invention as set forth in the claims.

WHAT IS CLAIMED IS:

1 1. A fiberoptic receiver, comprising:
2 an optical-to-electrical conversion element receiving optical
3 pulses from a communications network;
4 a bias circuit for applying bias to the optical-to-electrical
5 conversion element having a power supply outputting a voltage level,
6 wherein the bias circuit comprises at least first and second analog
7 control loops and a digital control loop, wherein the first analog control
8 loop provides a fast response current limit and the second analog control
9 loop provides bias adjustment for the optical-to-electrical conversion
10 element in response to variations of the optical power of the received
11 optical pulses, wherein the digital control loop provides digitally
12 controlled bias adjustment for the optical-to-electrical conversion
13 element in response to changes in temperature and/or voltage level output
14 by the power supply.

1 2. A fiberoptic receiver for receiving optical pulses from a
2 communications network, the receiver comprising:
3 an optical-to-electrical conversion element that draws a
4 current that is a function of the optical power of the received pulses;
5 at least one sensor that monitors one or more conditions of an
6 environment in which the receiver operates and that thereby obtains values
7 for the one or more conditions; and
8 circuitry that accesses one or more locations of a non-
9 volatile memory, the locations corresponding to the values and storing
10 data from which can be determined one or more parameters suitable for
11 controlling the operation of the receiver when the monitored conditions
12 have the values.

1 3. The receiver of claim 2, wherein the one or more
2 conditions include temperature.

1 4. The receiver of claim 2, wherein the one or more
2 conditions include a voltage provided by a power supply used to power the
3 receiver.

1 5. The receiver of claim 2, wherein:
2 the receiver includes:
3 a circuit that generates an average peak amplitude
4 voltage corresponding to the optical power of the received pulses;
5 and
6 a circuit that compares the average peak amplitude
7 voltage against a reference voltage and generates a loss-of-
8 incoming-signal alarm whenever the average peak amplitude voltage
9 falls below the reference voltage; and

10 the parameter is a value for the reference voltage.

1 6. The receiver of claim 2, where the one or more parameters
2 include a value of a bias voltage applied to the optical-to-electrical
3 conversion element.

1 7. The receiver of claim 6, wherein the value of the bias
2 voltage represents a best bias voltage.

1 8. The receiver of claim 6, further comprising:
2 a first control loop that reduces the bias voltage applied to
3 the optical-to-electrical conversion element whenever the current drawn by
4 the conversion element exceeds a first level, the first control loop
5 having a first response time.

1 9. The receiver of claim 8, further comprising:
2 a second control loop that reduces the bias voltage applied to
3 the optical-to-electrical conversion element whenever the current drawn by
4 the conversion element exceeds a second level, wherein the second control
5 loop has a second response time that is less than the first response time
6 and the second level exceeds the first level.

1 10. A fiberoptic receiver that receives optical pulses from a
2 communications network, the receiver comprising:

3 an optical-to-electrical conversion element that draws a
4 current whose magnitude is a function of the optical power of the received
5 pulses and of a bias voltage applied to the conversion element; and
6 a first control loop that reduces the bias voltage applied to
7 the optical-to-electrical conversion element whenever the current drawn by
8 the conversion element exceeds a first level, the first control loop
9 having a first response time.

1 11. The receiver of claim 10, further comprising:

2 a second control loop that reduces the bias voltage applied to
3 the optical-to-electrical conversion element whenever the current drawn by
4 the conversion element exceeds a second level, wherein the second control
5 loop has a second response time that is less than the first response time
6 and the second level exceeds the first level.

1 12. A method of calibrating a fiberoptic receiver that
2 comprises an optical-to-electrical conversion element receiving optical
3 pulses from a communications network during normal operation of the
4 receiver, a bias voltage being applied to the conversion element, the
5 method comprising, for each particular environment in a set of
6 environments in which the receiver could be deployed during normal
7 operation, the steps of:

8 placing the receiver in the particular environment;
9 determining a parameter of the receiver when operated in the
10 particular environment; and

11 storing the parameter in a memory at a location corresponding
12 to the particular environment, wherein during normal operation of the
13 receiver in an operating environment the memory is accessed at one or more
14 locations corresponding to the operating environment in order to obtain
15 data from which the parameter of the receiver when operated in the
16 operating environment can be determined.

1 13. The method of claim 12, wherein the set of environments
2 spans a range of temperatures.

1 14. The method of claim 12, wherein the set of environments
2 spans a range of values for a voltage output by a power supply used to
3 power the receiver.

1 15. The method of claim 12, wherein:
2 the receiver includes
3 a circuit for generating an average peak amplitude
4 voltage corresponding to the optical power of the received pulses,
5 and
6 a circuit for comparing the average peak amplitude
7 voltage against a reference voltage and for generating a loss-of-
8 incoming-signal alarm whenever the average peak amplitude voltage
9 falls below the reference voltage; and
10 the parameter is a value for the reference voltage.

11 16. The method of claim 12, wherein the parameter is a best
12 bias voltage for the conversion element.

1 17. The method of claim 16, wherein the step of determining a
2 parameter of the receiver comprises the steps of:
3 for each particular voltage from a first set of voltages
4 spanning a first voltage range by a first increment, setting the bias
5 voltage to the particular voltage, transmitting known data to the
6 receiver, and measuring an error rate for the receiver;
7 determining a first voltage from the first set of voltages
8 such that the measured error rate for the first voltage is smaller than
9 the error rate measured for any other voltage from the first set of
10 voltages;
11 for each particular voltage from a second set of voltages
12 spanning a second voltage range by a second increment, setting the bias
13 voltage to the particular voltage, transmitting known data to the
14 receiver, and measuring an error rate for the receiver, wherein:

15 the second increment is smaller than the first
16 increment;

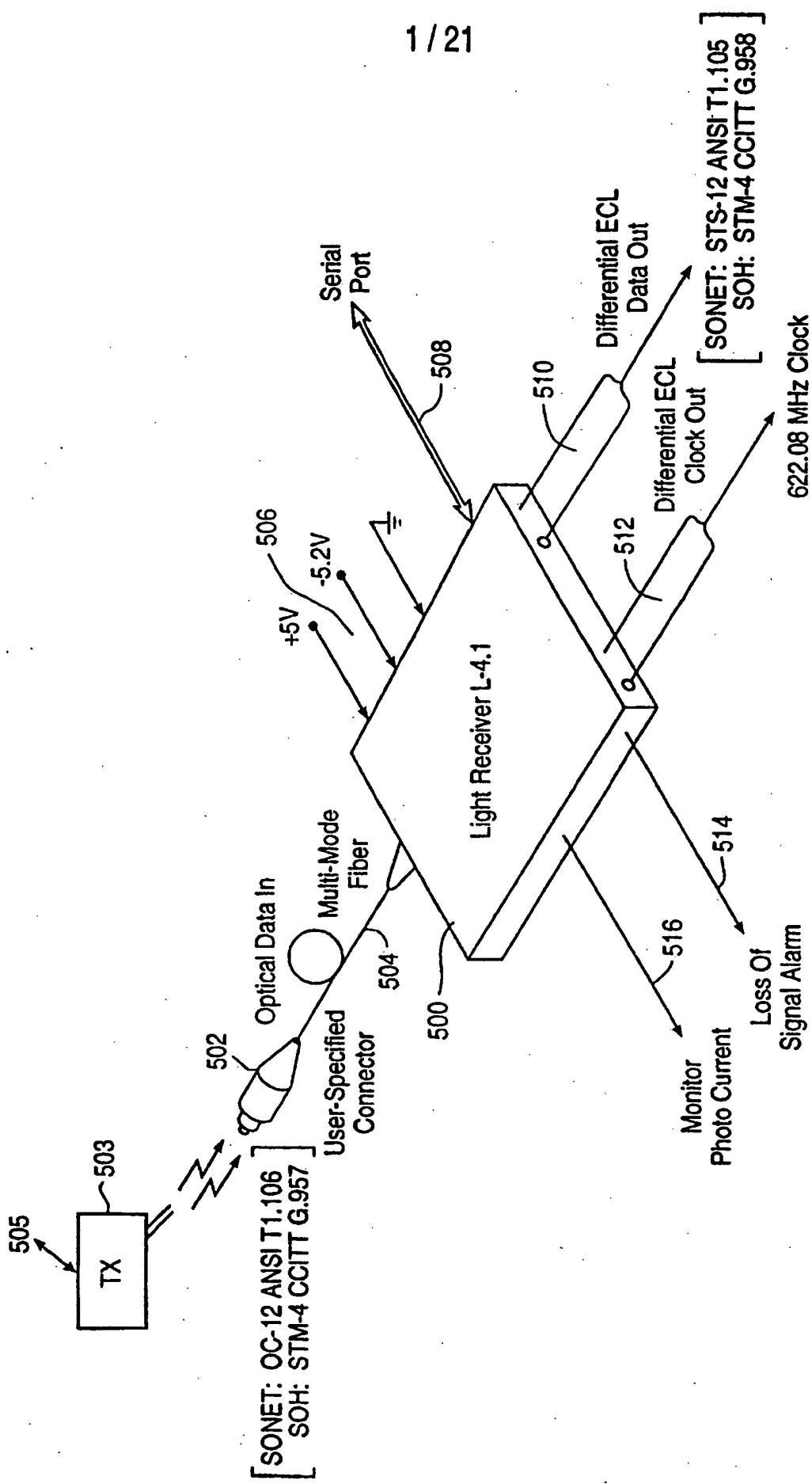
17 the second voltage range is smaller than the first
18 voltage range; and

19 the second voltage range is substantially centered
20 around the first voltage; and

21 determining that the best bias voltage for the conversion
22 element when operated in the particular environment is a second voltage
23 from the second set of voltages, wherein the measured error rate for the
24 second voltage from the second set of voltages is smaller than the error
25 rate measured for any other voltage from the second set of voltages.

1 18. The method of claim 17, wherein:
2 the conversion element has a breakdown voltage; and
3 the second range starts at a predetermined fraction of the
4 breakdown voltage and stops at the breakdown voltage.

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**FIG. 1**

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FIG. 2

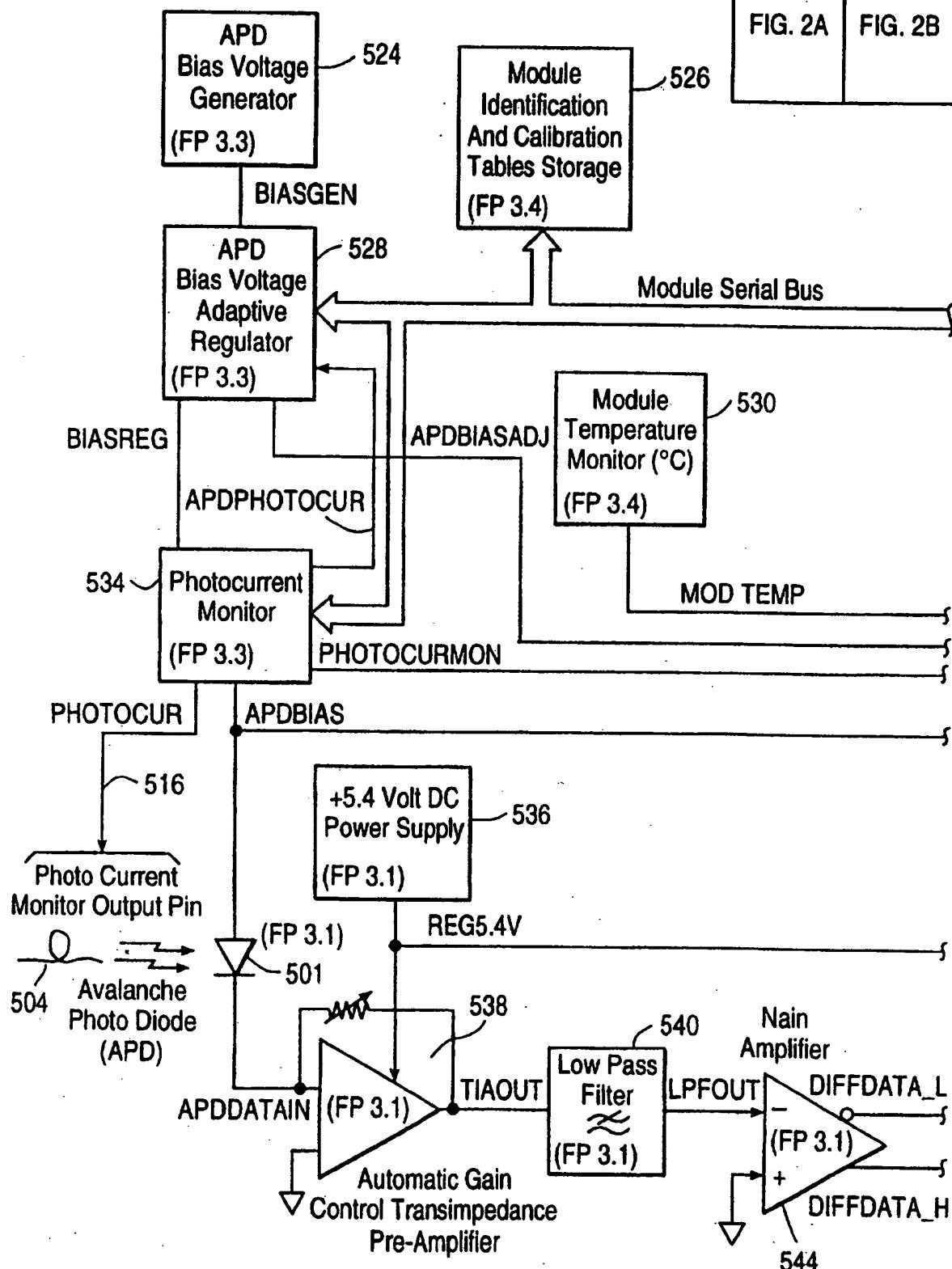
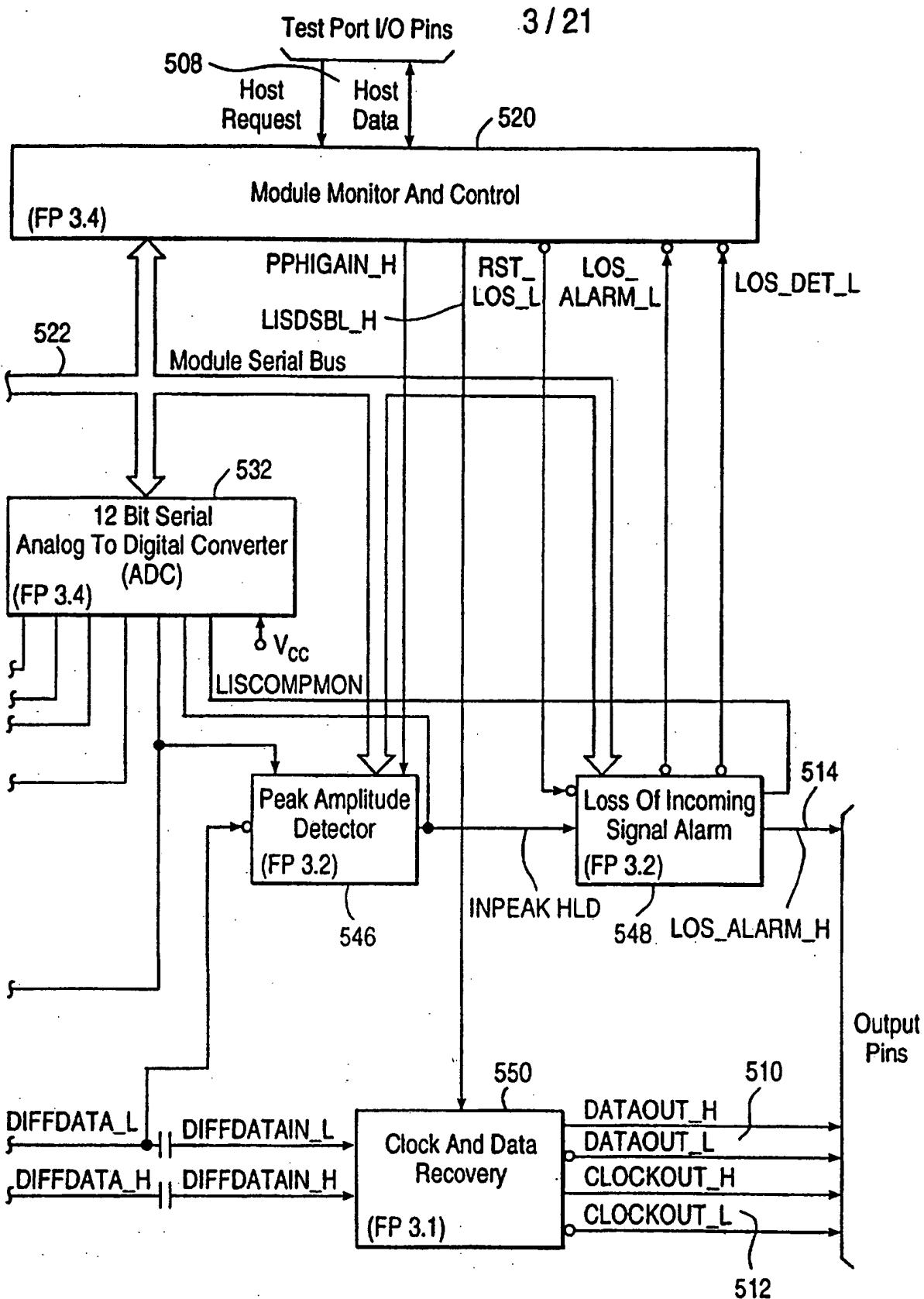
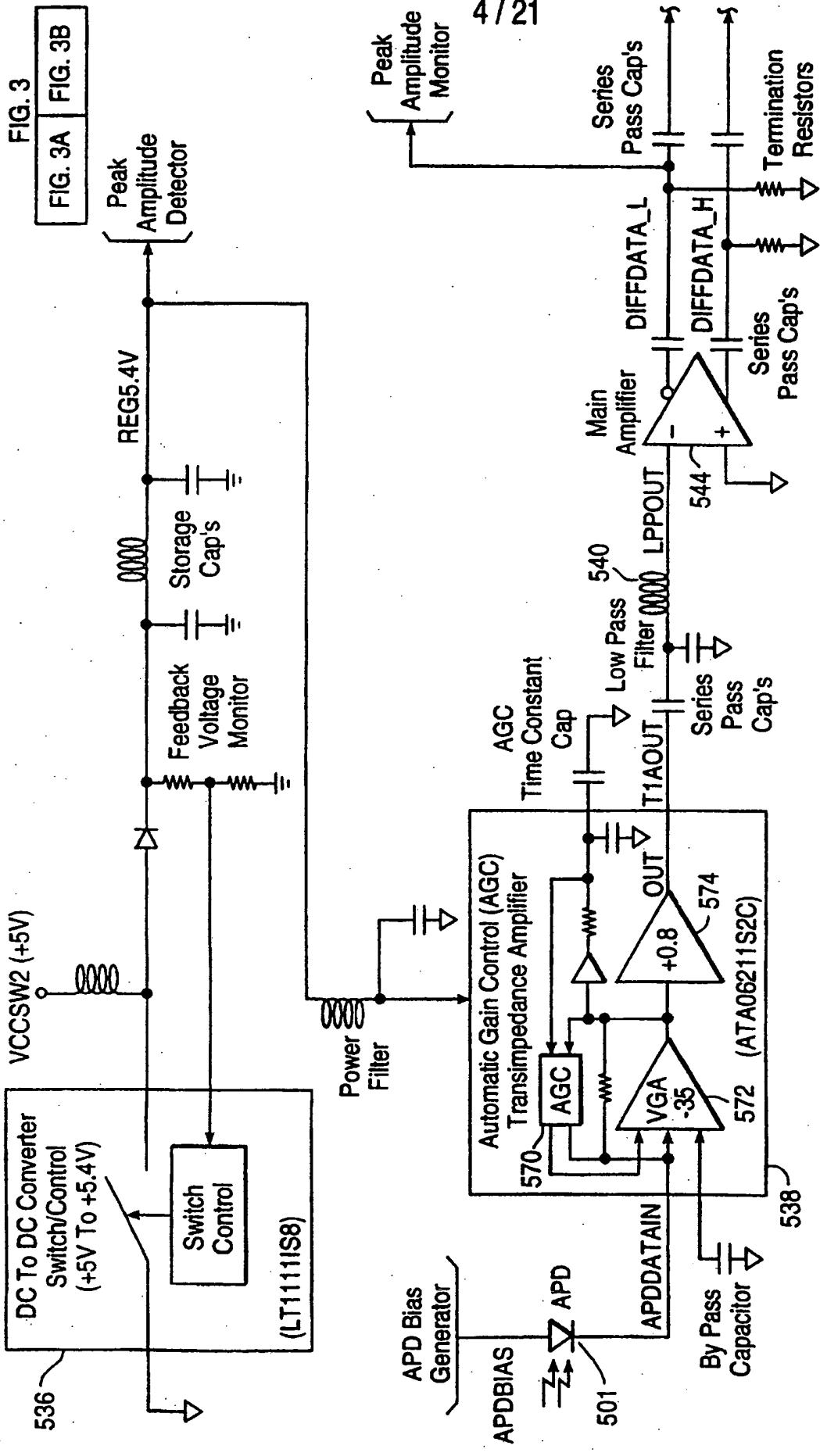


FIG. 2A

FIG. 2B →

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**FIG. 3A****Fig. 3B →**

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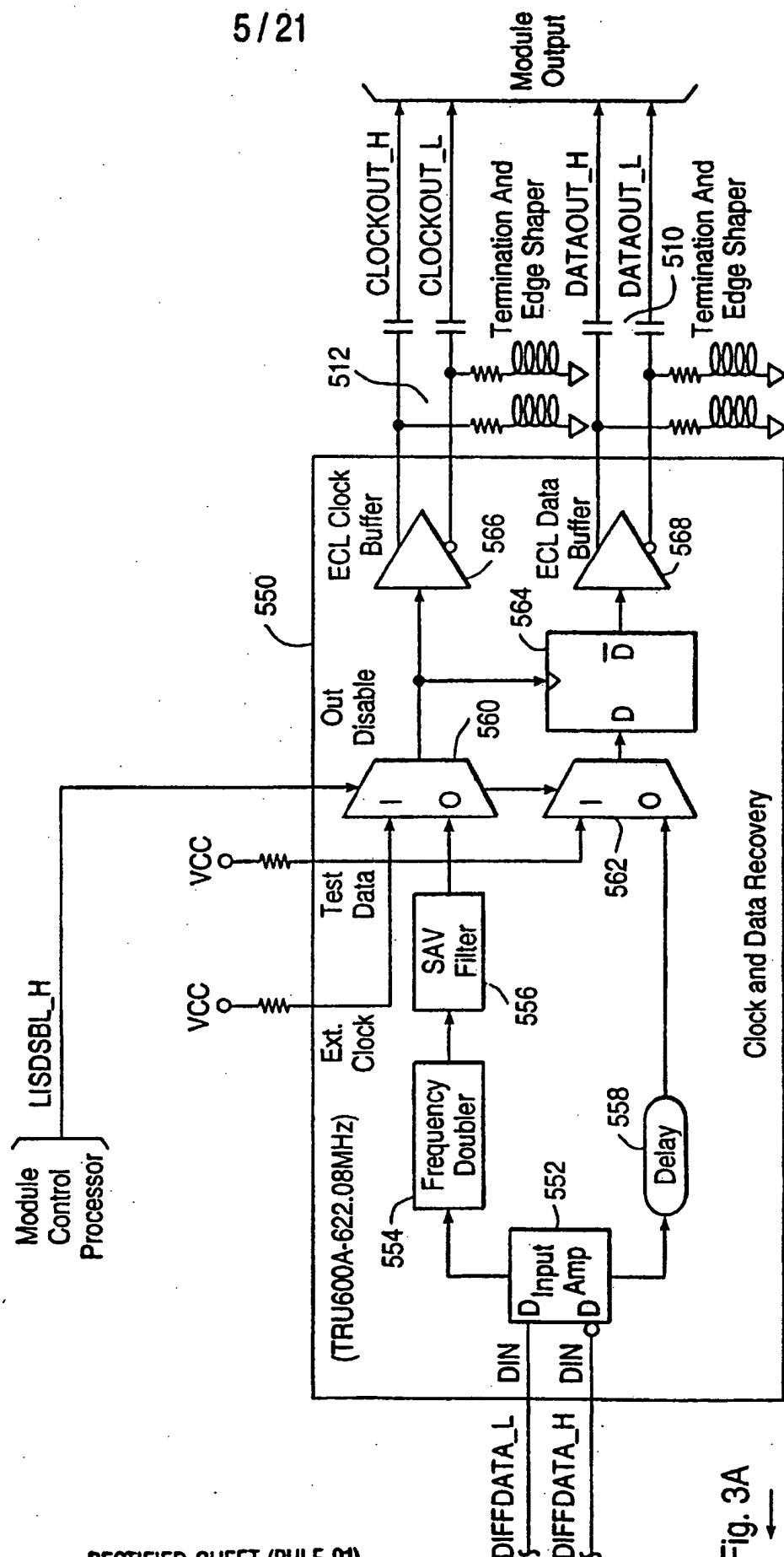
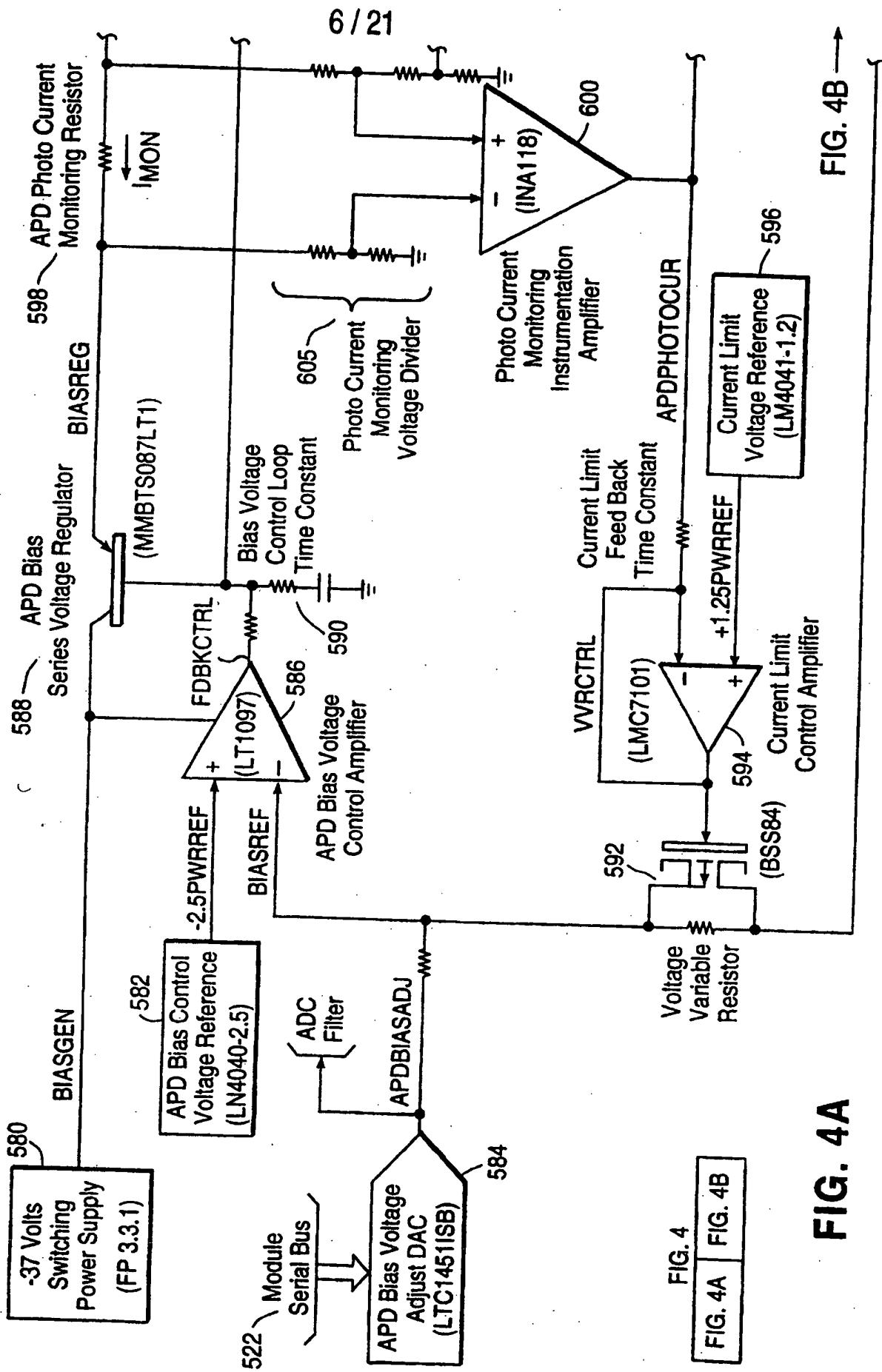
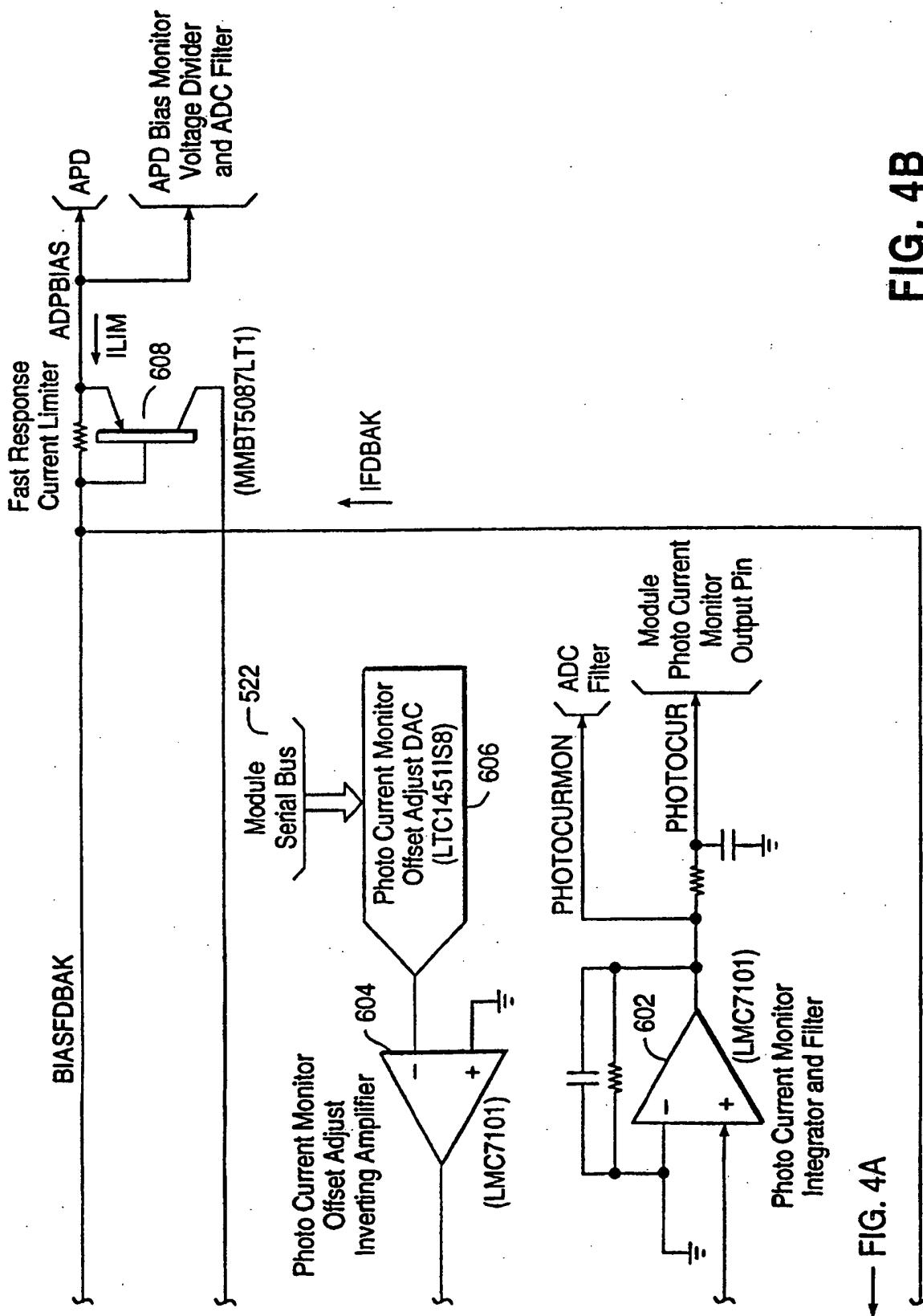
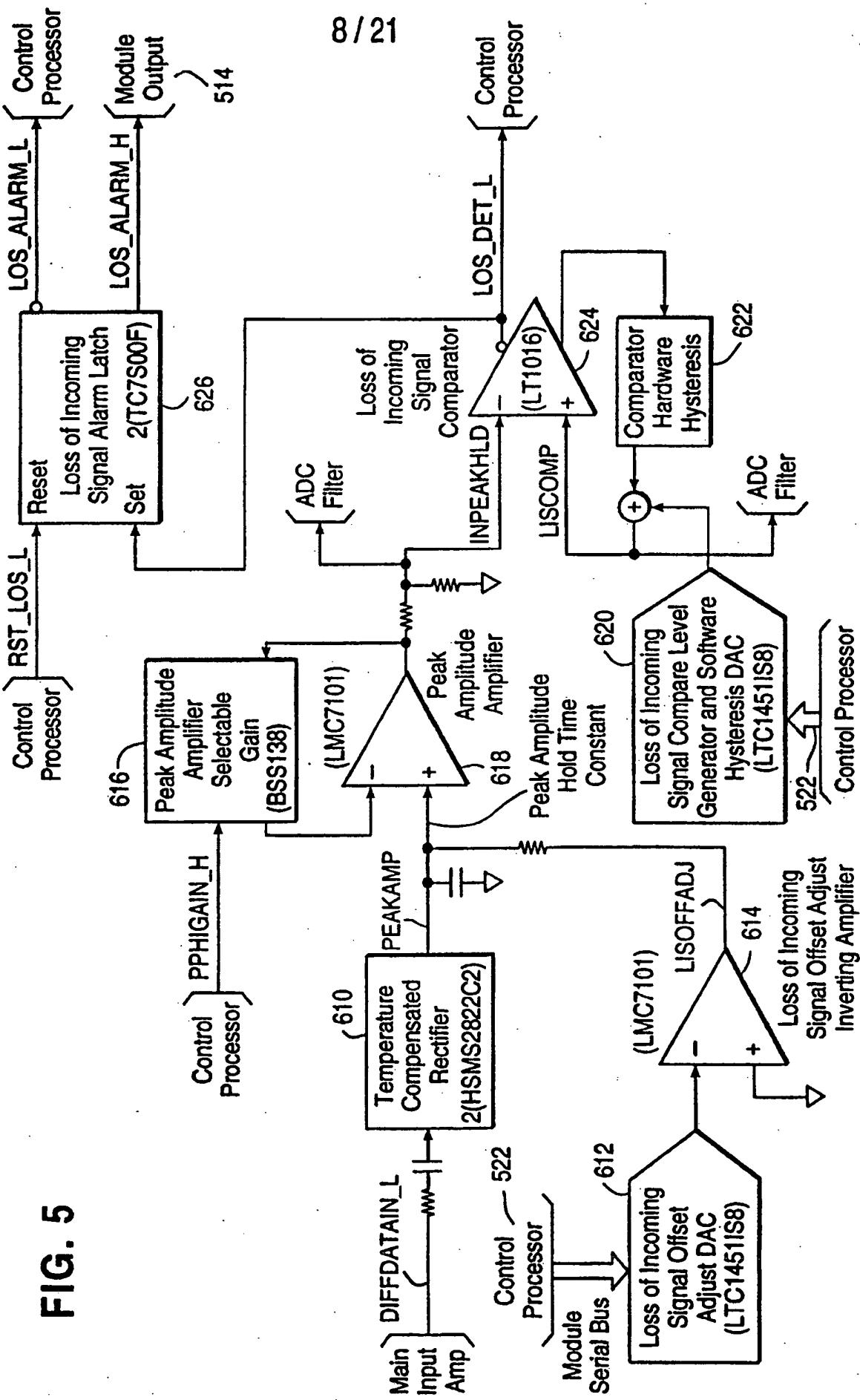


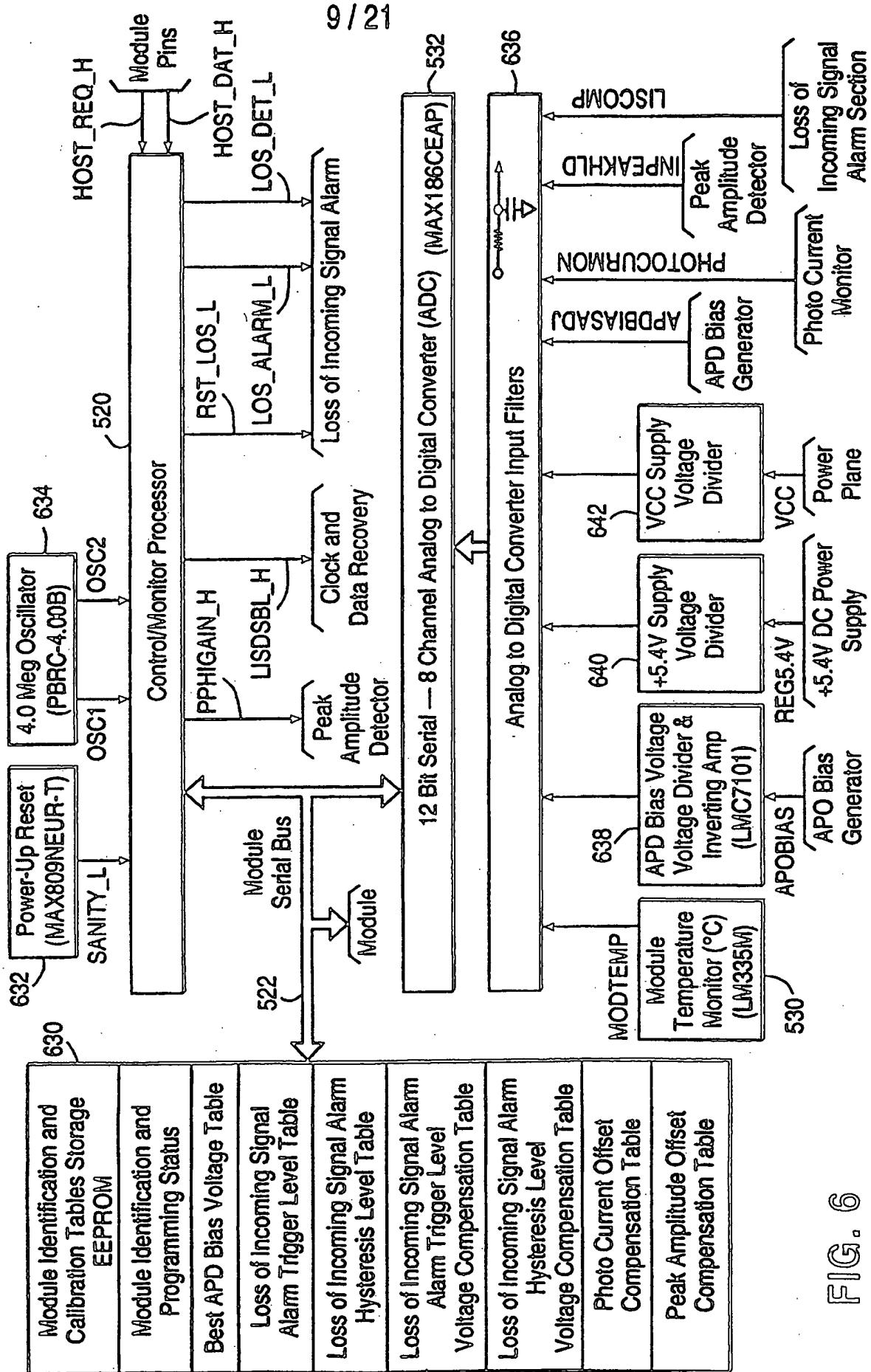
FIG. 3B



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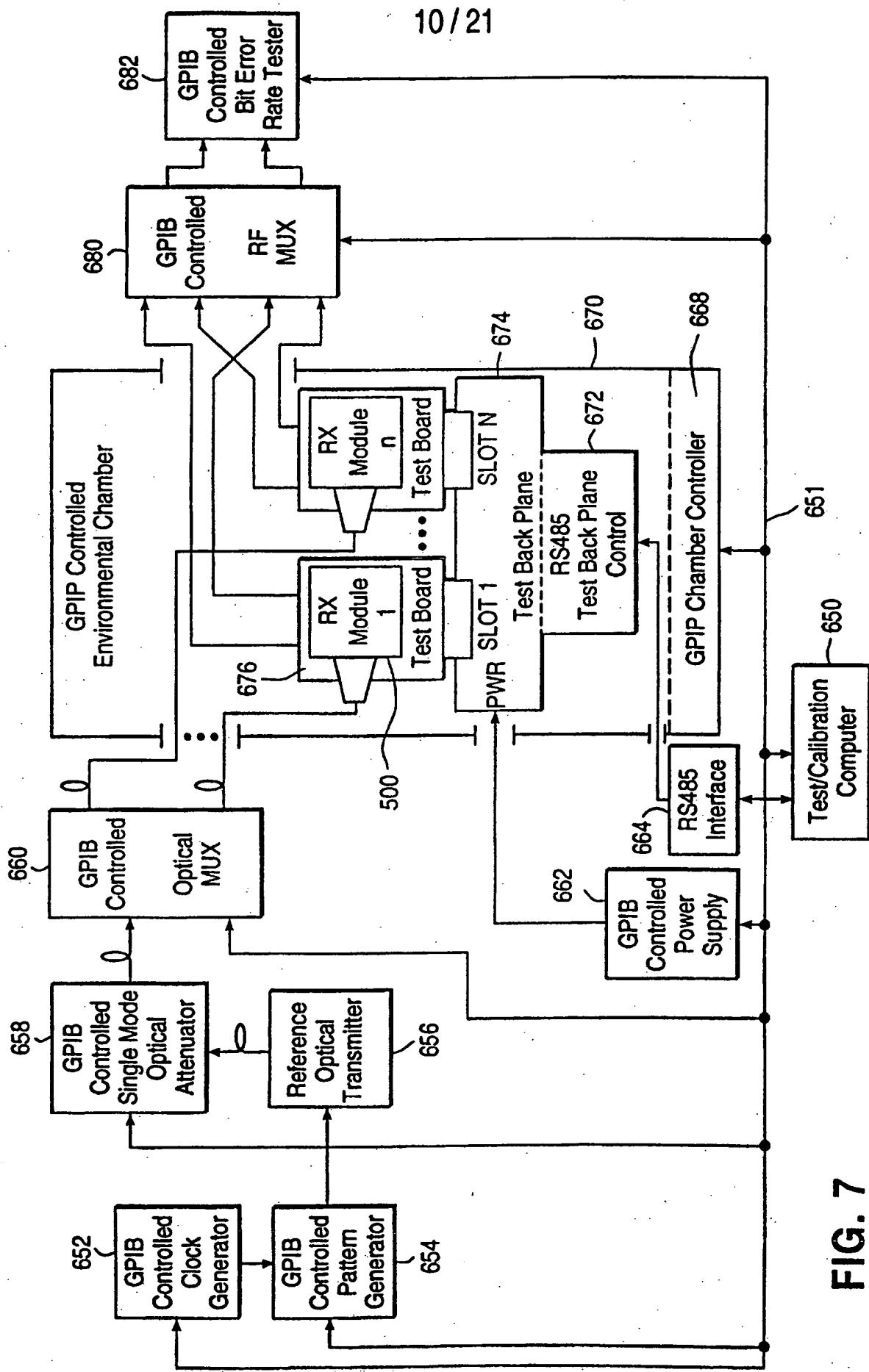


FIG. 7

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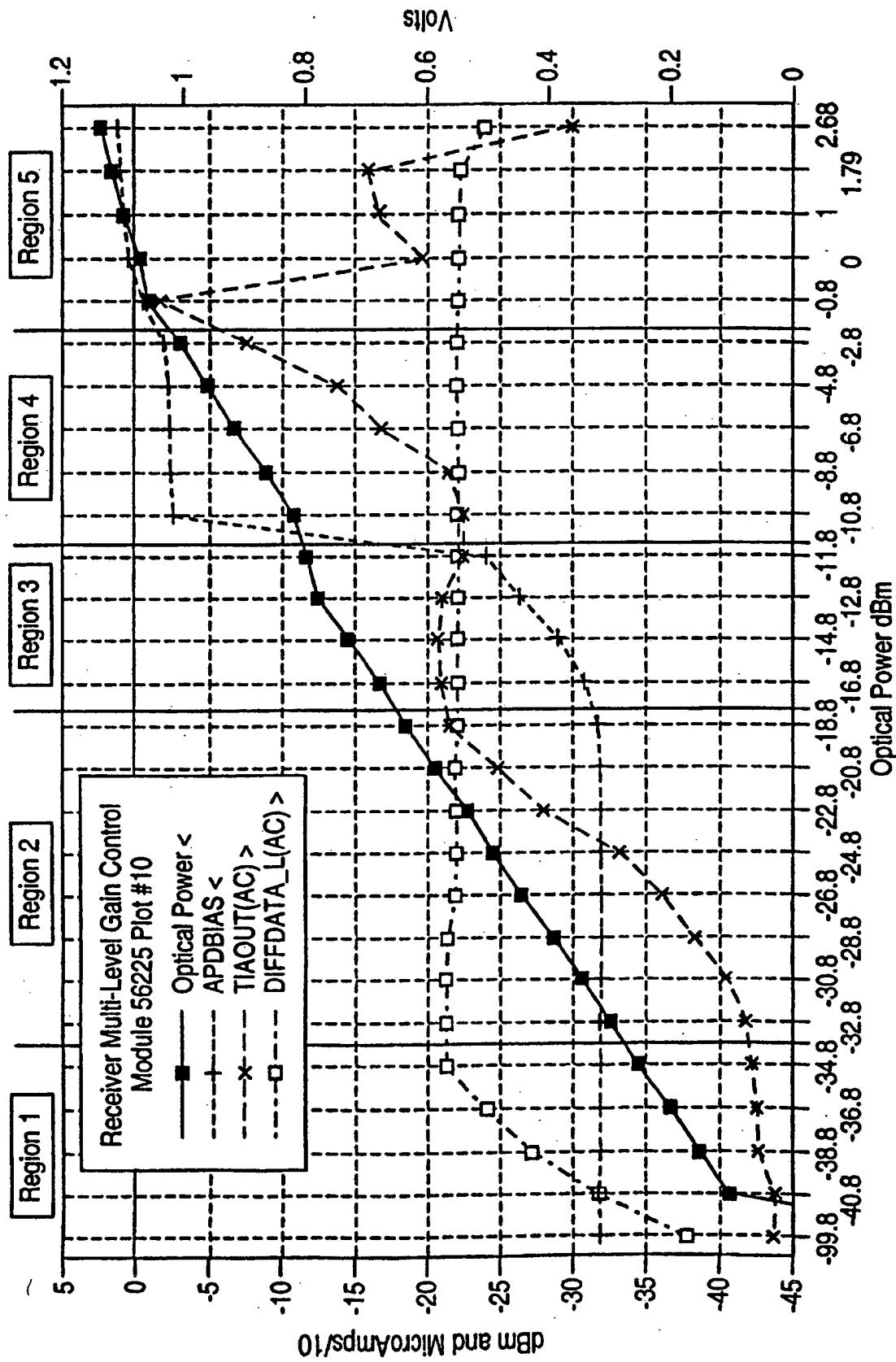
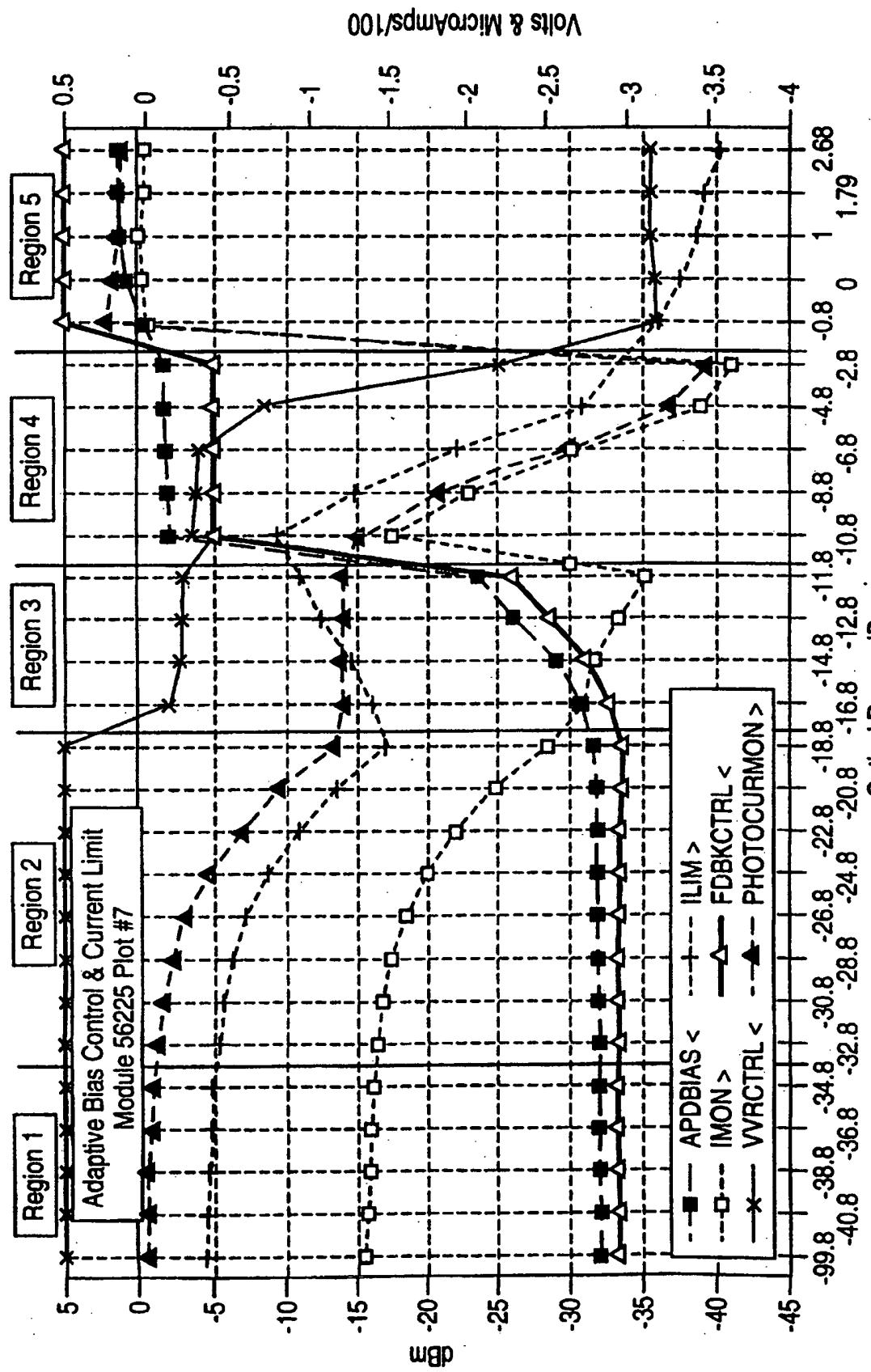


FIG. 8

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**FIG. 9**

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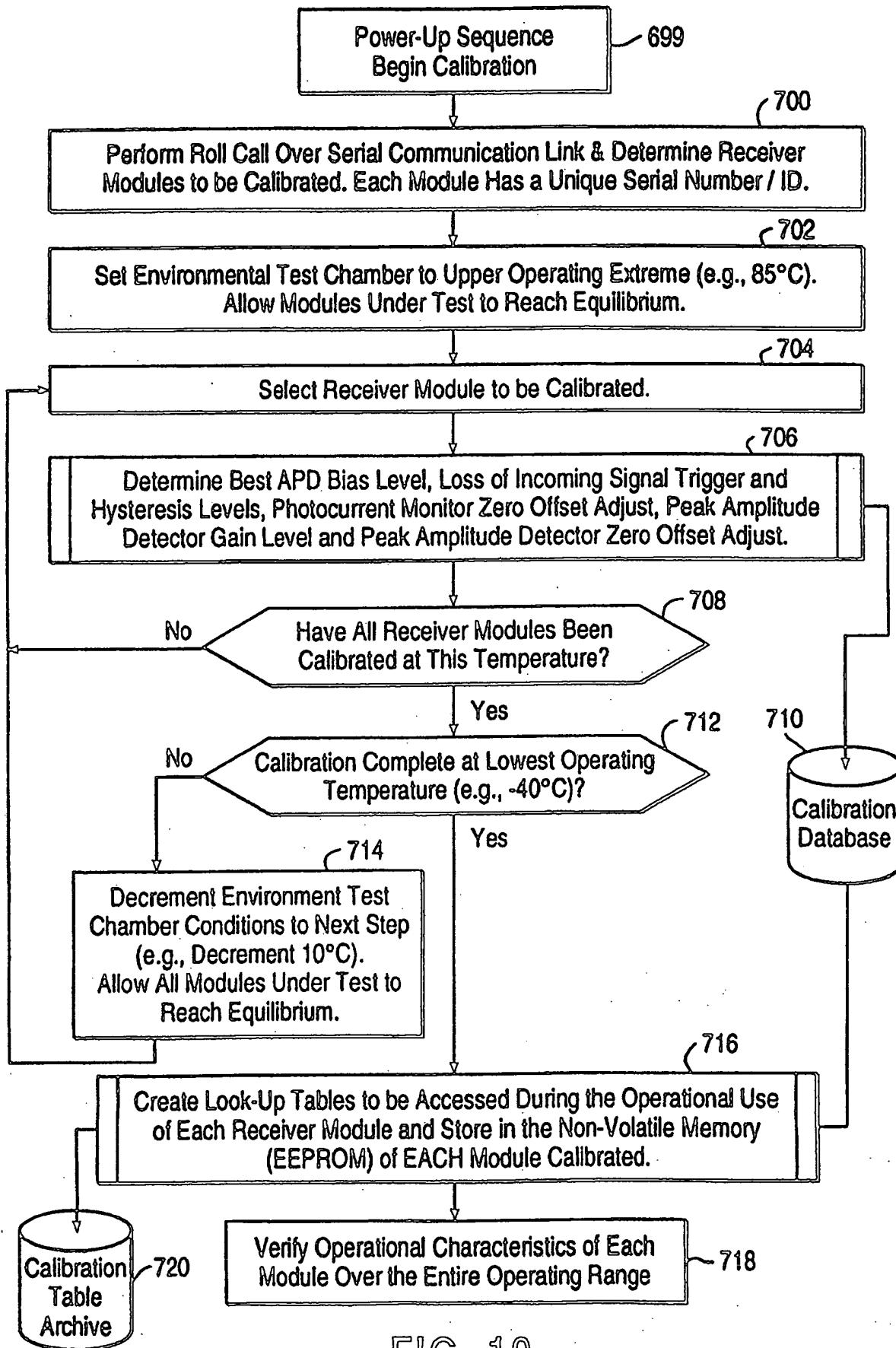


FIG. 10

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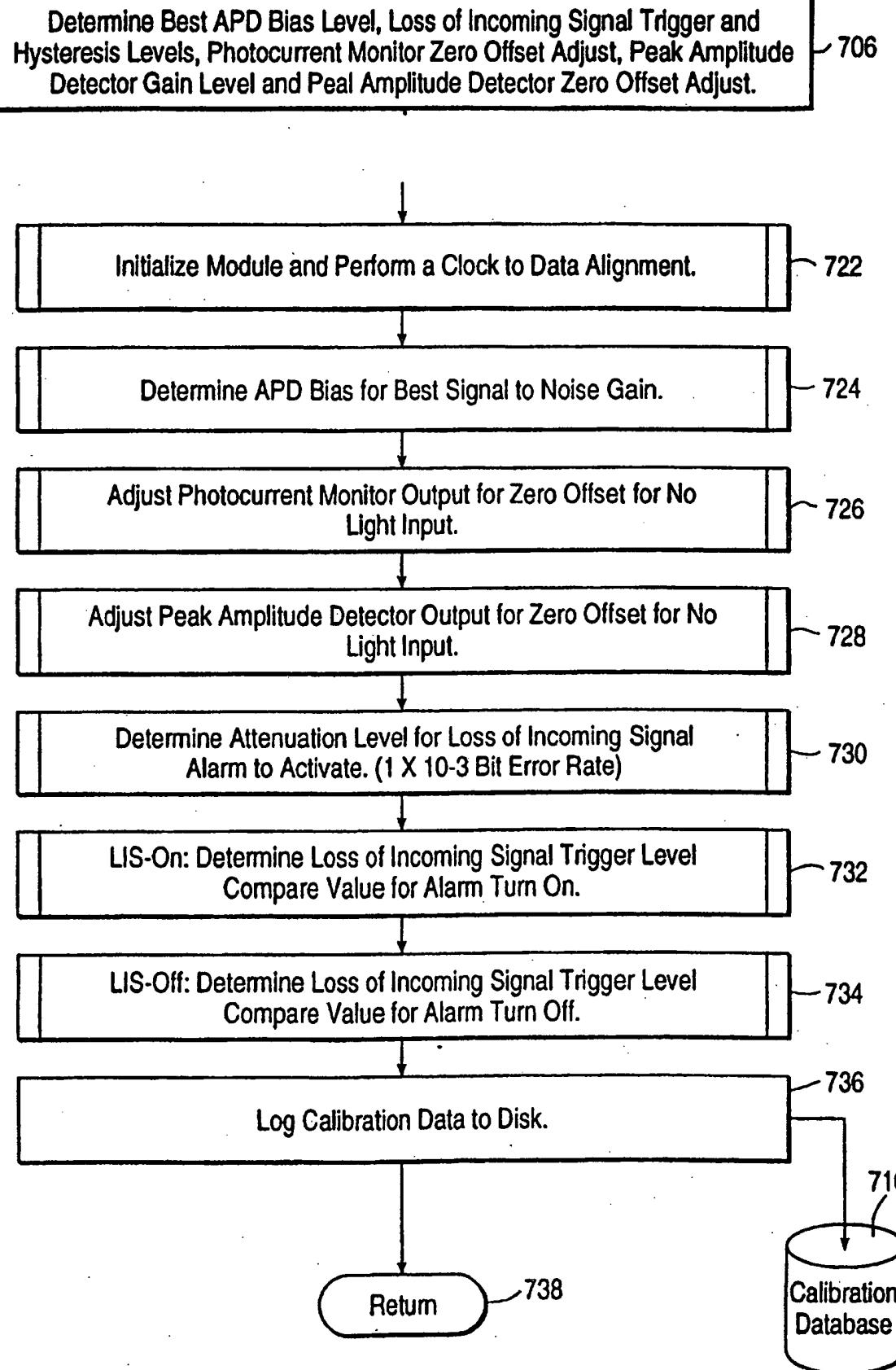


FIG. 11

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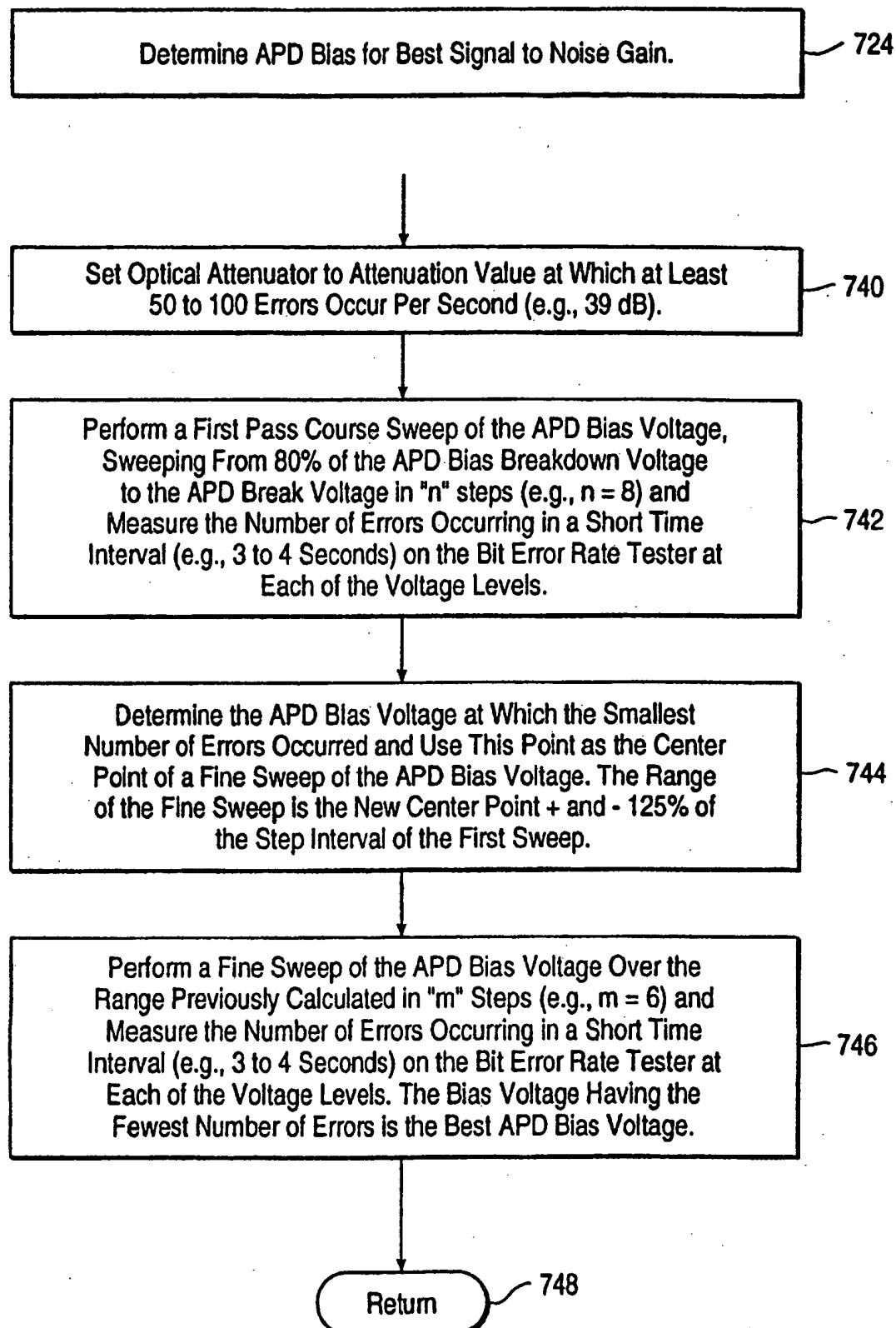


FIG. 12

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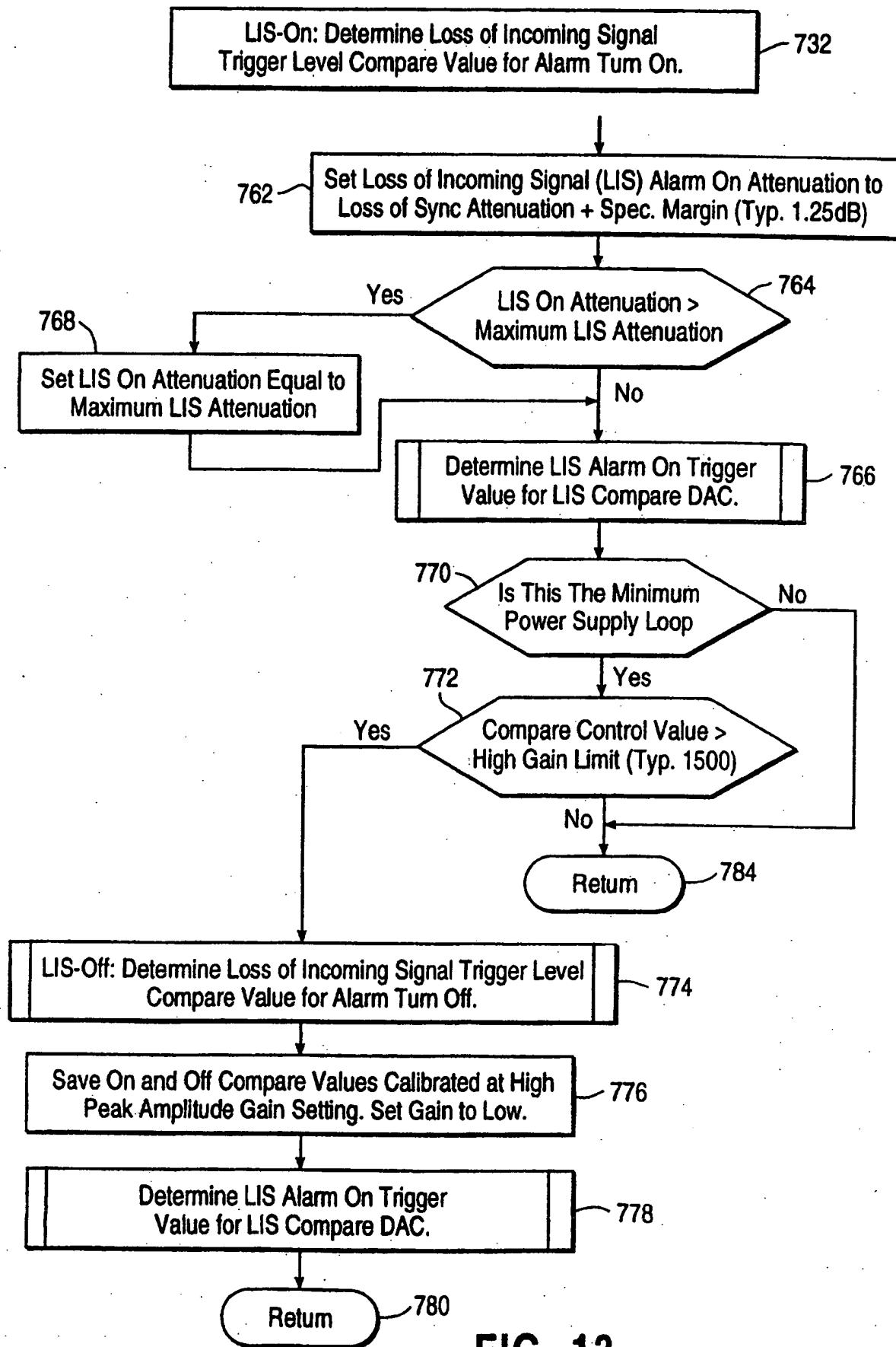
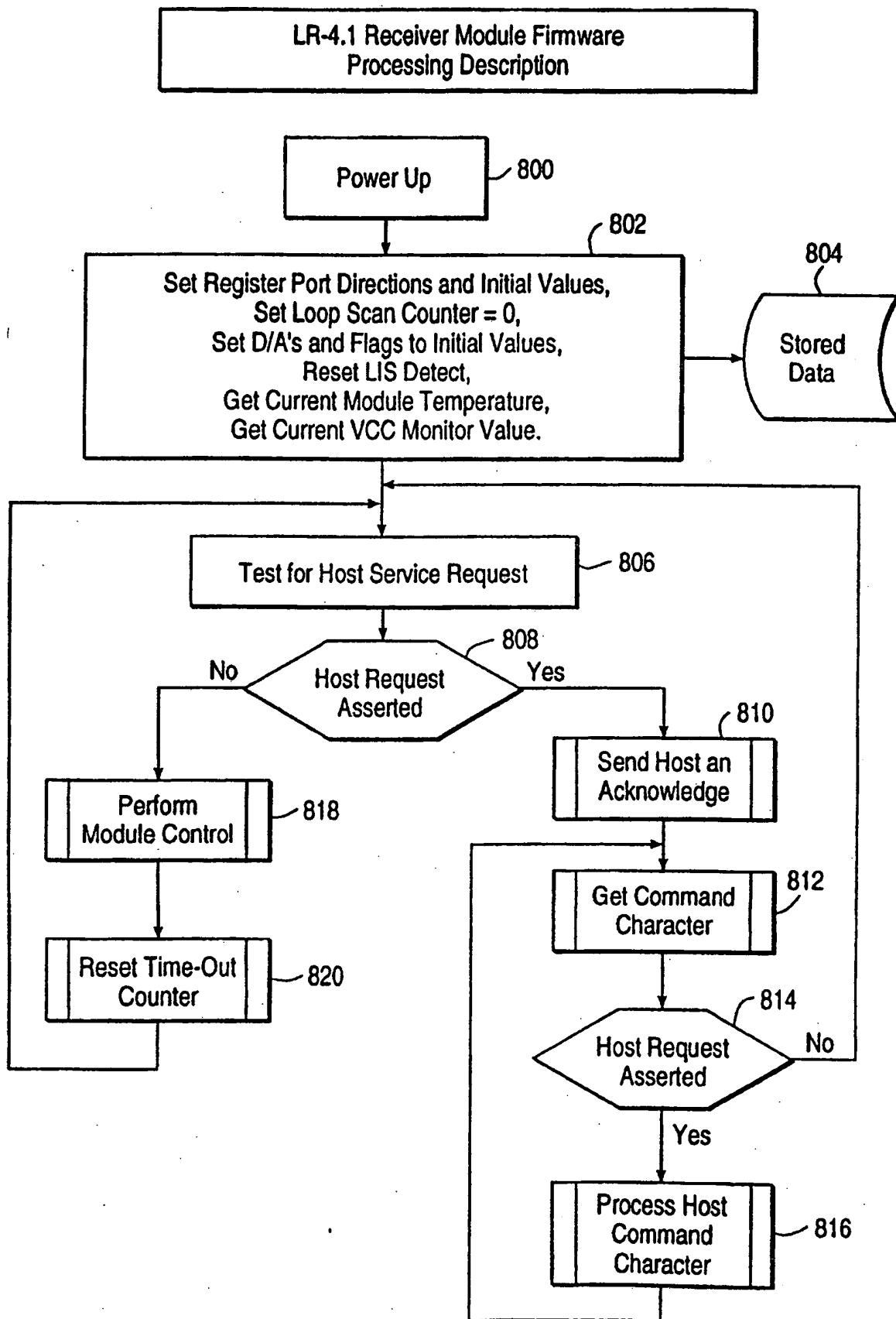


FIG. 13

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**FIG. 14**

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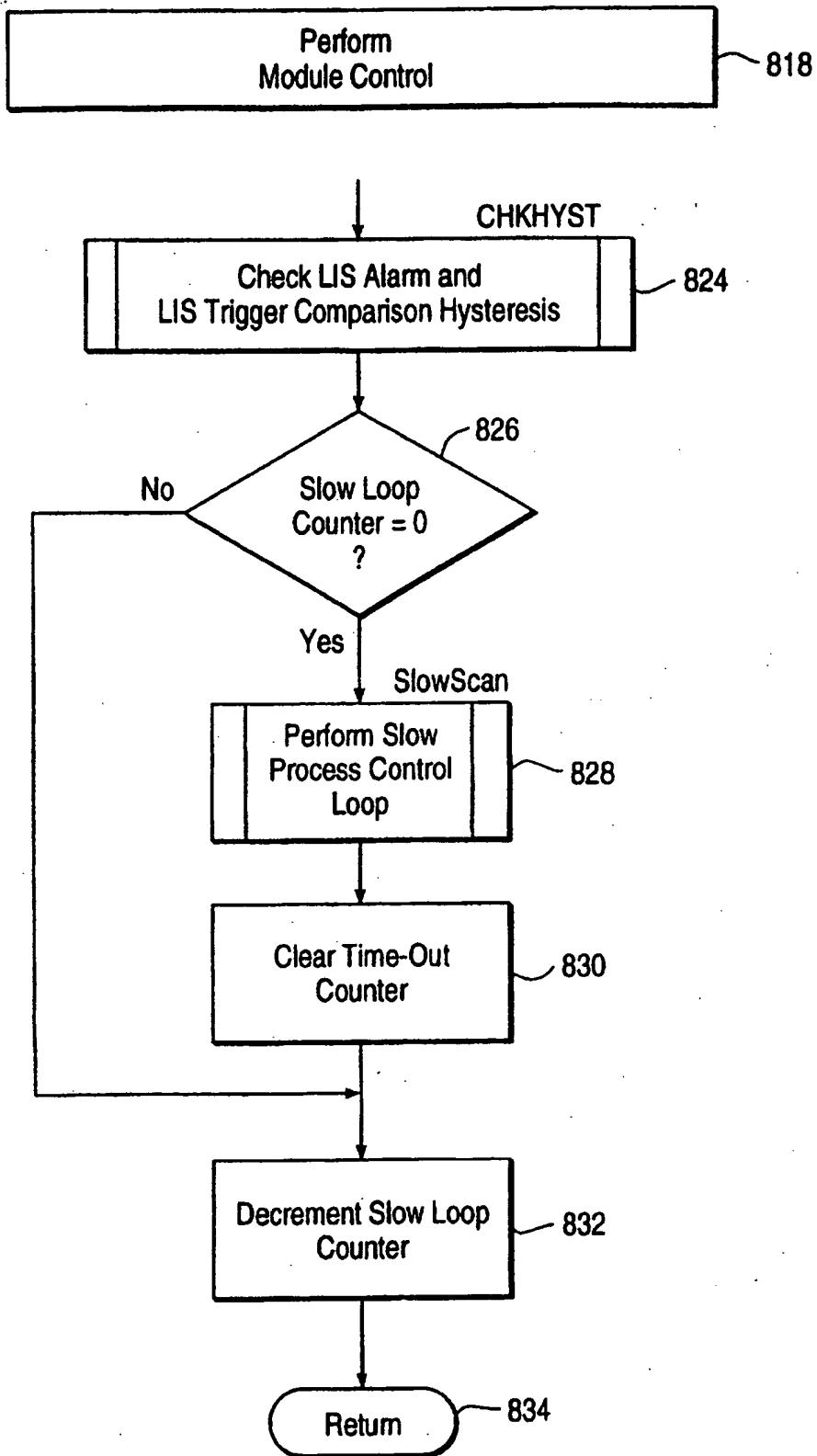


FIG. 15

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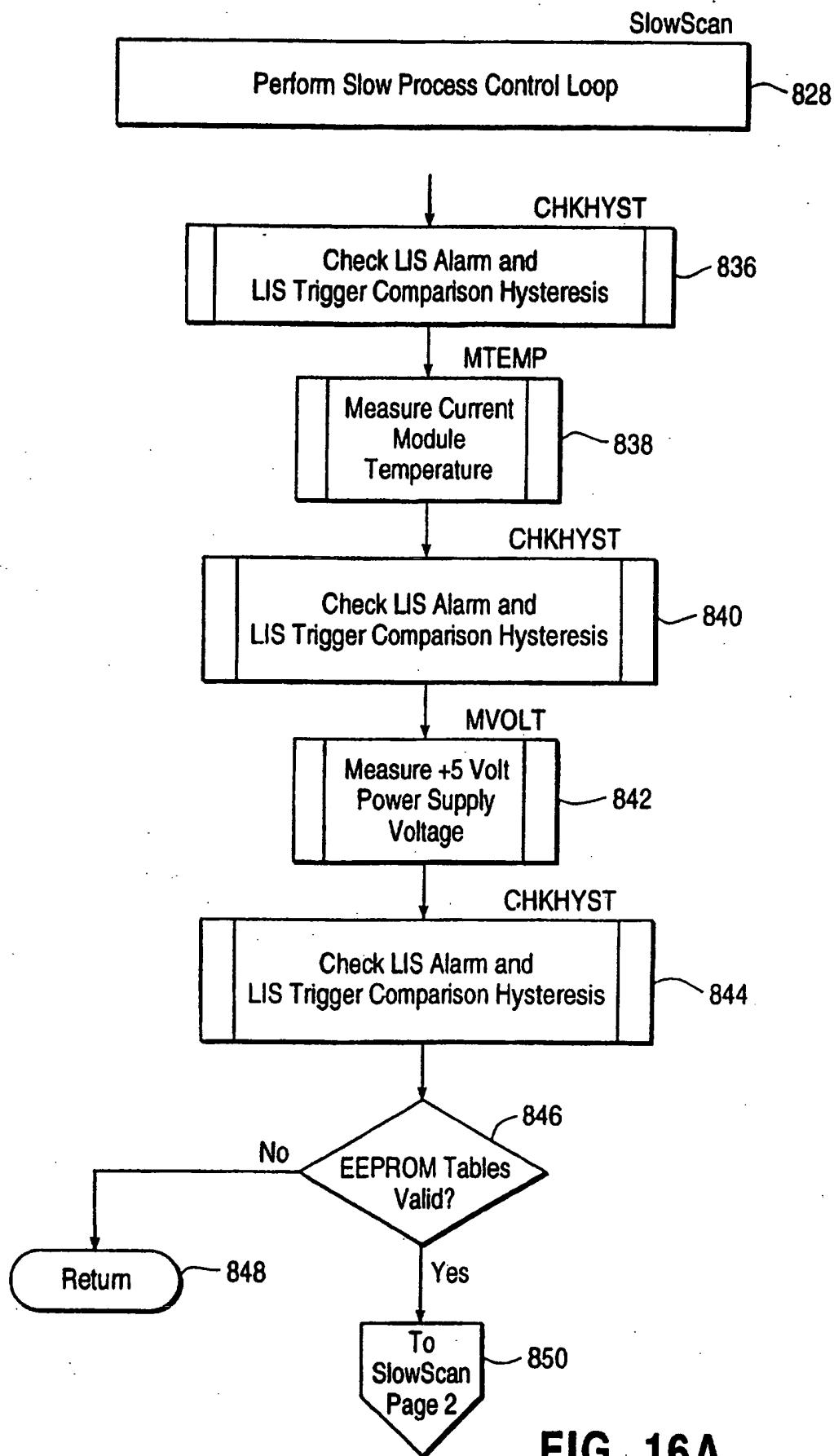
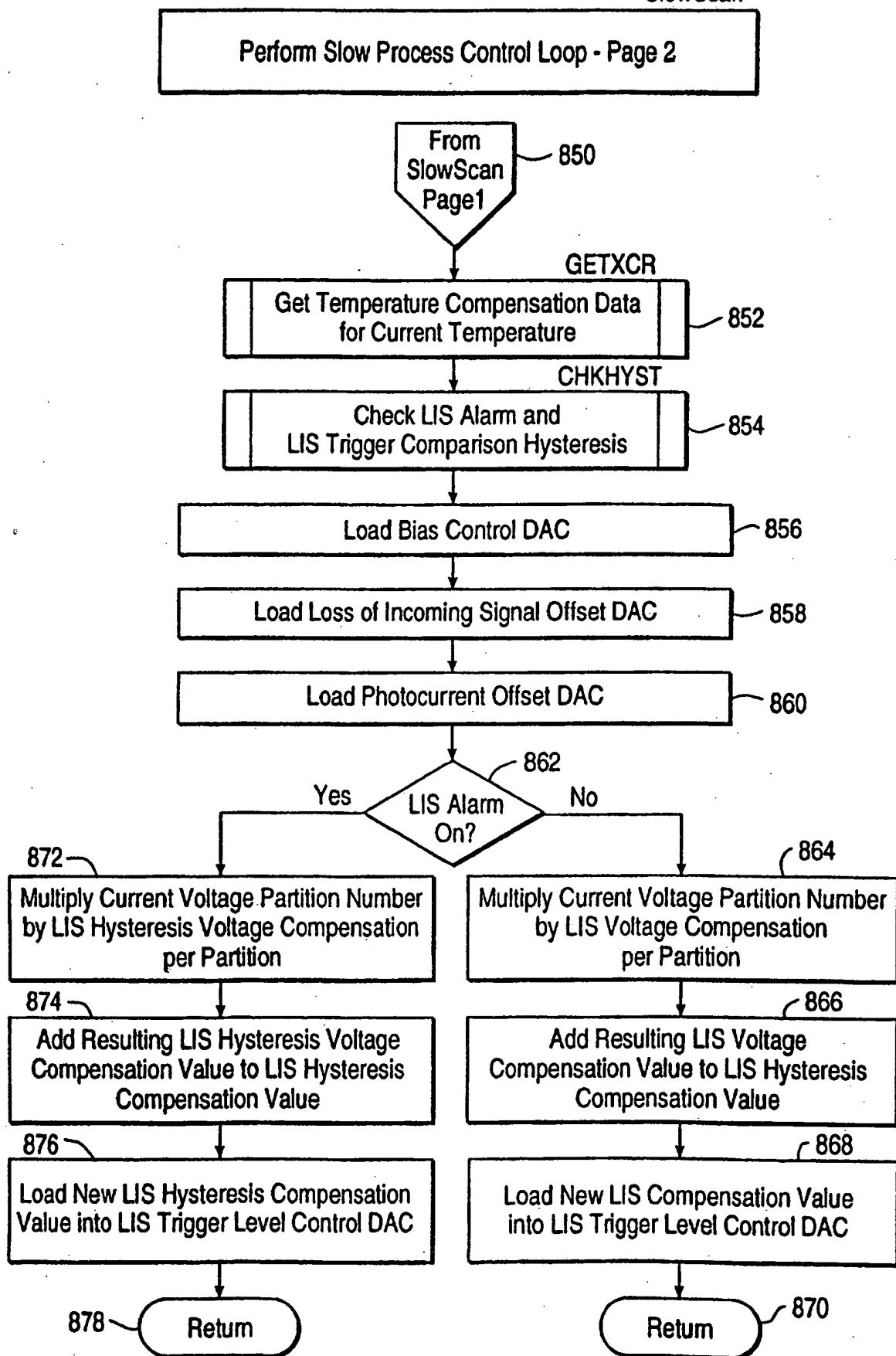


FIG. 16A

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SlowScan

**FIG. 16B**

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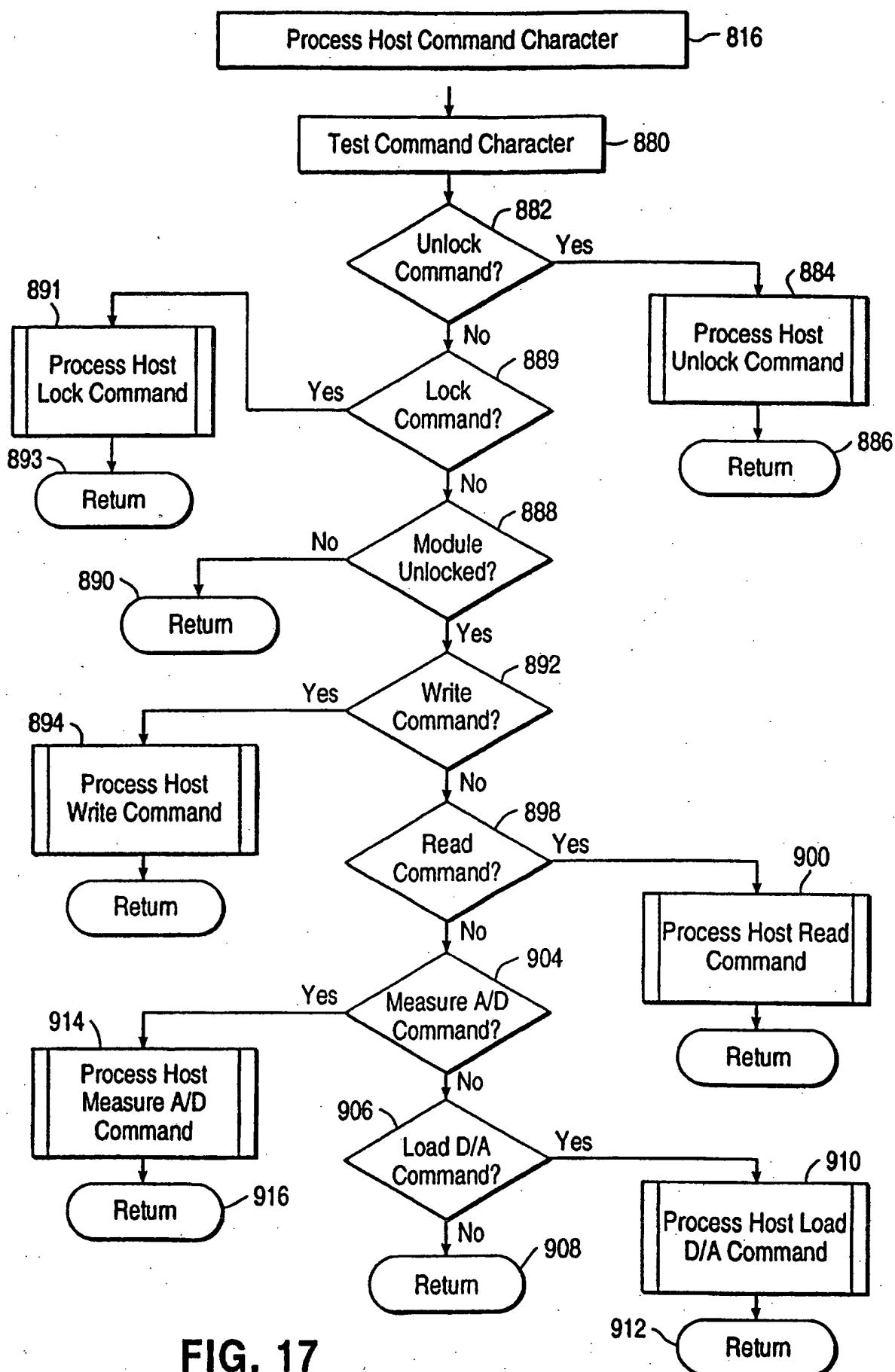


FIG. 17

INTERNATIONAL SEARCH REPORT

International application No.
PCT/US97/10930

A. CLASSIFICATION OF SUBJECT MATTER

IPC(6) :H04J 14/08; H04B 10/06

US CL :250/214A, 214C, 214AG, 205; 359/189, 194; 372/38, 26, 34

According to International Patent Classification (IPC) or to both national classification and IPC

B. FIELDS SEARCHED

Minimum documentation searched (classification system followed by classification symbols)

U.S. : 250/214A, 214C, 214AG, 205; 359/189, 194; 372/38, 26, 34

Documentation searched other than minimum documentation to the extent that such documents are included in the fields searched

Electronic data base consulted during the international search (name of data base and, where practicable, search terms used)

APS search, MAYA, DIALOG, JPOABS

C. DOCUMENTS CONSIDERED TO BE RELEVANT

Category ^a	Citation of document, with indication, where appropriate, of the relevant passages	Relevant to claim No.
Y,P	US 5,581,387 A (CAHILL) 03 DECEMBER 1996, COL. 3, LINES 65 THRU COL. 4, LINES 1-40	1-18
Y	US 5,111,324 A (JAHROMI) 05 MAY 1992, COL. 2, LINES 15 THRU COL. 3, LINES 42	1-18
Y	US 5,307,196 A (KINOSHITA) 26 APRIL 1994, COL. 4, LINES 31-66	2-16

Further documents are listed in the continuation of Box C.

See patent family annex.

•	Special categories of cited documents:	T	Document published after the international filing date or priority date and not in conflict with the application but cited to understand the background or theory underlying the invention
•A*	Document defining the general area of the art which is not considered to be of particular relevance		
•B*	Earlier document published on or after the international filing date	X*	Document of particular relevance; the claimed invention cannot be considered novel or cannot be considered to involve an inventive step when the document is taken alone
•C*	Document which may show details on priority claim(s) or which is cited to establish the publication date of another citation or other special reason (as specified)	Y*	Document of particular relevance; the claimed invention cannot be considered to involve an inventive step when the document is combined with one or more other such documents, such combination being obvious to a person skilled in the art
•D*	Document relating to an end disclaimer, an addition or other	Z*	Document member of the same patent family
•E*	Document published prior to the international filing date but later than the priority date claimed		

Date of the actual completion of the international search

10 AUGUST 1997

Date of mailing of the international search report

01 OCT 1997

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